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19-3134; Rev 1; 9/05

MAXIM

1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

General Description

The MAX9770/MAX9772 combine a mono, filterless, Class D speaker amplifier and stereo DirectDrive™ headphone amplifiers in a single device. The MAX9770/MAX9772 operate from a single 2.5V to 5.5V supply and include features that reduce external component count, system cost, board space, and offer improved audio reproduction.

The speaker amplifiers make use of Maxim's patented Class D architecture, providing Class AB performance with Class D efficiency, conserving board space, and extending battery life. The speaker amplifiers deliver 1.2W into an 8Ω load while offering efficiencies above 85%. A spread-spectrum modulation scheme reduces radiated emissions caused by the modulation frequency. Furthermore, the MAX9770/MAX9772 oscillators can be synchronized to an external clock through the SYNC input, avoiding possible problem frequencies inside a system. The speaker amplifier features THD+N as low as 0.025%, high 70dB PSRR, and SNR in excess of 90dB.

The headphone amplifiers feature Maxim's patented DirectDrive architecture that produces a ground-referenced output from a single supply, eliminating the need for large DC-blocking capacitors. The headphone amplifiers deliver up to 80mW into a 16Ω load, feature low 0.015% THD+N, high 85dB PSRR, and ±8kV ESD-protected outputs. A headphone sense input detects the presence of a headphone, and automatically configures the amplifiers for either speaker or headphone mode.

The MAX9770/MAX9772 include internally set, logic-selectable gain, and a comprehensive input multiplexer/mixer, allowing multiple audio sources to be selected and for true mono reproduction of a stereo source in speaker mode. Industry-leading click-and-pop suppression eliminates audible transients during power and shutdown cycles. A low-power shutdown mode decreases supply current consumption to 0.1µA, further extending battery life.

The MAX9770 is offered in space-saving, thermally efficient 28-pin TQFN (5mm x 5mm x 0.8mm) and 28-pin TSSOP packages, while the MAX9772 is offered in a tiny (2.54mm x 2.54mm x 0.62mm) 25-bump chip-scale package (UCSP™). The MAX9770/MAX9772 feature thermal-overload and output short-circuit protection, and are specified over the extended -40°C to +85°C temperature range.

Applications

Cellular Phones PDAs

Compact Notebooks

UCSP is a trademark of Maxim Integrated Products, Inc.

Features

- **1.2W Filterless Class D Amplifiers Pass FCC Class B Radiated EMI Standards with 100mm of Cable**
- **Patented Spread-Spectrum Mode Offers 5dB EMI Improvement over Conventional Methods**
- **80mW DirectDrive Headphone Amplifier Eliminates Bulky DC-Blocking Capacitors**
- **High 85dB PSRR at 217Hz**
- **85% Efficiency**
- **Low 0.015% THD+N**
- **Industry-Leading Click-and-Pop Suppression**
- **Integrated 2-Way Input Mixer/Multiplexer (MAX9772)**
- **Integrated 3-Way Input Mixer/Multiplexer (MAX9770)**
- **Logic-Adjustable Gain**
- **Short-Circuit and Thermal Protection**
- **Available in Space-Saving, Thermally Efficient Packages**

Ordering Information

PART	PIN-PACKAGE	PKG CODE	SELECTABLE INPUTS
MAX9770ETI+	28 TQFN-EP*	T2855N-1	2 stereo, 1 mono
MAX9770EUI	28 TSSOP	U28-1	2 stereo, 1 mono
MAX9772EBA-T	5 x 5 UCSP	B25-1	1 stereo, 1 mono

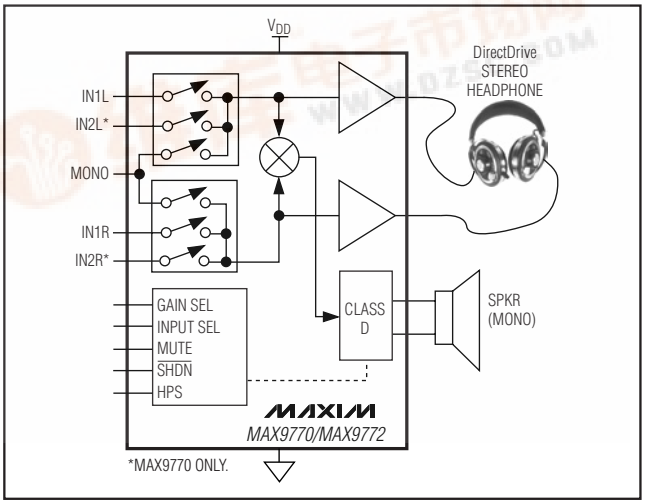
Note: *All devices specified over the -40°C to +85°C operating temperature range.*

**EP = Exposed paddle.*

+Denotes lead-free package.

Pin Configuration appears at end of data sheet.

Simplified Block Diagram



For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at

1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

ABSOLUTE MAXIMUM RATINGS

GND to PGND to CPGND.....-0.3V to +0.3V
V_{DD} to PV_{DD} to CPV_{DD}.....-0.3V to +0.3V
V_{DD} to GND .....+6V
PV_{DD} to PGND.....+6V
CPV_{DD} to CPGND.....+6V
CPV_{SS} to CPGND.....-6V
SV_{SS} to GND .....-6V
C1N.....(PV_{SS} - 0.3V) to (CPGND + 0.3V)
HPOUT_ to GND .....±3V
All Other Pins to GND.....-0.3V to (V_{DD} + 0.3V)
Continuous Current Into/Out of:
  PV_{DD}, PGND, OUT_.....600mA
  PV_{SS}.....260mA
Duration of HPOUT_ Short Circuit to V_{DD}, PV_{DD}, GND, PGND .....Continuous
Duration of Short Circuit Between HPOUTL and HPOUTR .....Continuous
Duration of OUT_ Short Circuit to V_{DD}, PV_{DD}, GND, PGND ..10s
Duration of Short Circuit Between OUT+ and OUT-.....10s
Continuous Power Dissipation (T_A = +70°C)
  5 x 5 UCSP (derate 15.85mW/°C above +70°C) 1.268W
  28-Pin TQFN (derate 20.8mW/°C above +70°C) 1667mW
  28-Pin TSSOP (derate 12.8mW°C above +70°C) 1026mW
Junction Temperature.....+150°C
Operating Temperature Range .....-40°C to +85°C
Storage Temperature Range .....-65°C to +150°C
Bump Temperature (soldering) Reflow.....+235°C
Lead Temperature (soldering, 10s) .....+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{DD} = PV_{DD} = CPV_{DD} = 3.3V, GND = PGND = CPGND = 0V, $\overline{SHDN}$ = 3.3V, C1 = C2 = 1µF, C_{BIAS} = 0.047µF, SYNC = GND, R_L = ∞, speaker load connected between OUT+ and OUT-, headphone load connected between HPOUT_ and GND, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS			MIN	TYP	MAX	UNITS
GENERAL								
Supply Voltage Range	V_{DD}	Inferred from PSRR test			2.5		5.5	V
Quiescent Supply Current	I_{DD}	No load	Headphone mode			5.5	10	mA
			Speaker mode			5.2	7.5	
Shutdown Supply Current	I_{SHDN}	$\overline{SHDN}$ = HPS = GND				0.1	10	µA
Shutdown to Full Operation	t_{ON}					50		ms
Input Impedance	R_{IN}	(Note 3)	MONO		7	10		kΩ
			INL_, INR_		14	20		
Bias Voltage	V_{BIAS}				1.1	1.25	1.4	V
Feedthrough		From any unselected input to any output, f = 10kHz				70		dB
SPEAKER AMPLIFIER (GAIN1 = GAIN2 = V_{DD}, HPS = GND)								
Output Offset Voltage	V_{OS}					±15	±70	mV
Power-Supply Rejection Ratio	PSRR	(Note 4)	V_{DD} = 2.5V to 5.5V, T_A = +25°C	MAX9770	50	70		dB
				MAX9772	48			
			V_{RIPPLE} = 200mV_{P-P}, f = 217Hz			70		
			V_{RIPPLE} = 200mV_{P-P}, f = 1kHz			68		
			V_{RIPPLE} = 200mV_{P-P}, f = 20kHz			50		
Output Power	P_{OUT}	f = 1kHz, THD+N = 1%, GAIN1 = 1, GAIN2 = 0	V_{DD} = 3.3V	R_L = 8Ω		550		mW
				R_L = 4Ω		900		
			V_{DD} = 5V	R_L = 8Ω		1200		

1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

ELECTRICAL CHARACTERISTICS (continued)

(V_{DD} = PV_{DD} = CPV_{DD} = 3.3V, GND = PGND = CPGND = 0V, $\overline{SHDN}$ = 3.3V, C1 = C2 = 1µF, C_{BIAS} = 0.047µF, SYNC = GND, R_L = ∞, speaker load connected between OUT+ and OUT-, headphone load connected between HPOUT_ and GND, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS			MIN	TYP	MAX	UNITS
Total Harmonic Distortion Plus Noise	THD+N	R_L = 8Ω, P_{OUT} = 300mW, f = 1kHz				0.025		%
		R_L = 4Ω, P_{OUT} = 300mW, f = 1kHz				0.03		
		MAX9772, R_L = 8Ω, P_{OUT} = 500mW, f = 1kHz				0.1		
Signal-to-Noise Ratio	SNR	R_L = 8Ω, V_{OUT} = $2V_{RMS}$, A-weighted				85.9		dB
Output Switching Frequency	f_S	SYNC = GND			980	1100	1220	kHz
		SYNC = FLOAT			1280	1450	1620	
		SYNC = V_{DD}				1220 ±120kHz		
SYNC Frequency Lock Range					800		2000	kHz
Efficiency	η	P_O = 1000mW, f = 1kHz				85		%
Gain (MAX9770)	A_V	GAIN1 = 0, GAIN2 = 0				6		dB
		GAIN1 = 0, GAIN2 = 1				3		
		GAIN1 = 1, GAIN2 = 0				9		
		GAIN1 = 1, GAIN2 = 1				0		
Gain (MAX9772)	A_V	GAIN1 = 0, GAIN2 = 0				15.6		dB
		GAIN1 = 0, GAIN2 = 1				12		
		GAIN1 = 1, GAIN2 = 0				20		
		GAIN1 = 1, GAIN2 = 1				6		
Gain Accuracy							±5	%
Speaker Path Off-Isolation		HPS = V_{DD}, headphone amplifier active, f = 1kHz				102		dB
Click-and-Pop Level	K_{CP}	Peak voltage, A-weighted, 32 samples per second (Notes 4, 5)	Into shutdown			-76		dB
			Out of shutdown			-55		
			Into mute			-83		
			Out of mute			-69		
HEADPHONE AMPLIFIER (GAIN1 = 1, GAIN2 = 0, HPS = V_{DD})								
Output Offset Voltage	V_{OS}	MAX9770				±5	±10	mV
		MAX9772					±14	
Power-Supply Rejection Ratio	PSRR	(Note 4)	V_{DD} = 2.5V to 5.5V, T_A = +25°C		65	76		dB
			MAX9770, V_{RIPPLE} = $200mV_{P-P}$, f = 217Hz			75		
			MAX9772, V_{RIPPLE} = $200mV_{P-P}$, f = 217Hz			85		
			V_{RIPPLE} = $200mV_{P-P}$, f = 1kHz			82		
			V_{RIPPLE} = $200mV_{P-P}$, f = 20kHz			56		
Output Power	P_{OUT}	T_A = +25°C, f = 1kHz, THD+N = 1% (Note 3)	V_{DD} = 3.3V	R_L = 32Ω	40	55		mW
				R_L = 16Ω		40		
			V_{DD} = 5V	R_L = 32Ω		60		
				R_L = 16Ω		80		

1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

ELECTRICAL CHARACTERISTICS (continued)

(V_{DD} = PV_{DD} = CPV_{DD} = 3.3V, GND = PGND = CPGND = 0V, $\overline{SHDN}$ = 3.3V, C1 = C2 = 1µF, C_{BIAS} = 0.047µF, SYNC = GND, R_L = ∞, speaker load connected between OUT+ and OUT-, headphone load connected between HPOUT_ and GND, T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Notes 1, 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
Total Harmonic Distortion Plus Noise	THD+N	R_L = 32Ω, P_{OUT} = 50mW, f = 1kHz			0.015		%
		R_L = 16Ω, P_{OUT} = 35mW, f = 1kHz			0.03		
Signal-to-Noise Ratio	SNR	R_L = 32Ω, V_{OUT} = 300mV_{RMS}, BW = 22Hz to 22kHz			101		dB
Crosstalk		Between channels, f = 1kHz, V_{IN} = 200mV_{P-P}			80		dB
Headphone Off-Isolation		HPS = GND, speaker amplifier active, f = 1kHz			96		dB
Click-and-Pop Level	K_{CP}	Peak voltage, A-weighted, 32 samples per second (Notes 4, 5)	Into shutdown		-58		dBV
			Out of shutdown		-53		
			Into mute		-92		
			Out of mute		-73		
Capacitive-Load Drive	C_L				1000		pF
Gain	A_V	GAIN1 = 0, GAIN2 = 0			7		dB
		GAIN1 = 0, GAIN2 = 1			4		
		GAIN1 = 1, GAIN2 = 0			-2		
		GAIN1 = 1, GAIN2 = 1			1		
Gain Accuracy						±2.5	%
ESD Protection		HPOUTR, HPOUTL, IEC Air Discharge			±8		kV
DIGITAL INPUTS ($\overline{SHDN}$, SYNC, HPS, GAIN_, SEL_)							
Input Voltage High	V_{IH}			2			V
Input Voltage Low	V_{IL}					0.8	V
Input Leakage Current (Note 6)		SYNC input				±25	µA
		All other logic inputs				±1	
HPS Input Current		HPS = GND				-10	µA

Note 1: All devices are 100% production tested at +25°C. All temperature limits are guaranteed by design.

Note 2: Speaker amplifier testing performed with a resistive load in series with an inductor to simulate an actual speaker load. For R_L = 4Ω, L = 47µH. For R_L = 8Ω, L = 68µH.

Note 3: Guaranteed by design, not production tested.

Note 4: Inputs AC-coupled to GND.

Note 5: Speaker mode testing performed with an 8Ω resistive load in series with a 68µH inductive load connected across BTL output. Headphone mode testing performed with a 32Ω resistive load connected to GND. Mode transitions are controlled by $\overline{SHDN}$. K_{CP} level is calculated as: 20 x log [(peak voltage during mode transition, no input signal)/(peak voltage under normal operation at rated power level)]. Units are expressed in dB. Measured with V_{DD} = 5V.

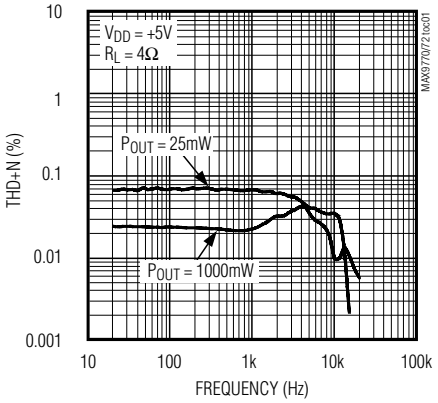
Note 6: SYNC has a 200kΩ resistor to V_{REF} = 1.25V.

1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

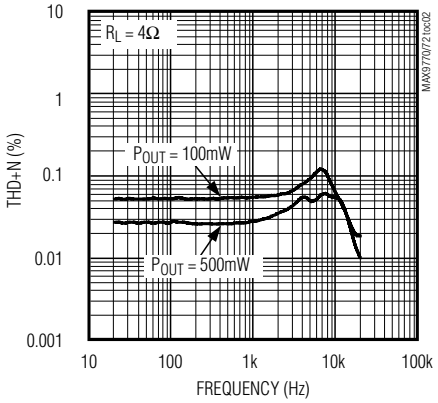
Typical Operating Characteristics

(MAX9770 V_{DD} = 3.3V, BW = 22Hz to 22kHz, GAIN1 = 1, GAIN2 = 0, spread-spectrum mode, headphone outputs in phase, unless otherwise noted.)

TOTAL HARMONIC DISTORTION PLUS NOISE vs. FREQUENCY (SPEAKER MODE)



TOTAL HARMONIC DISTORTION PLUS NOISE vs. FREQUENCY (SPEAKER MODE)



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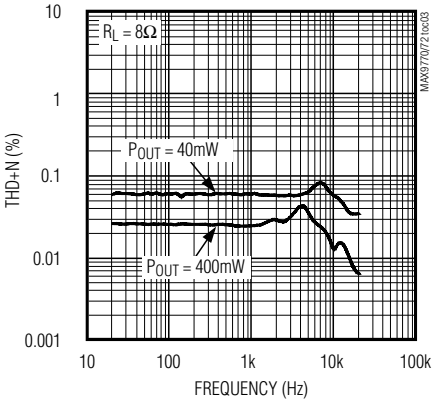

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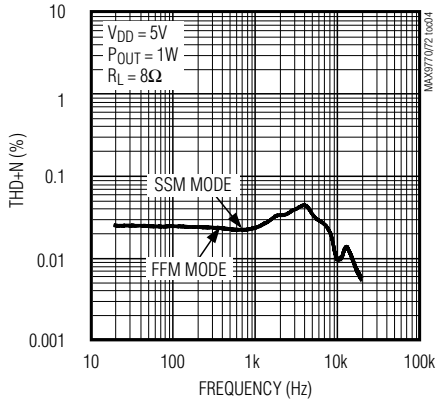
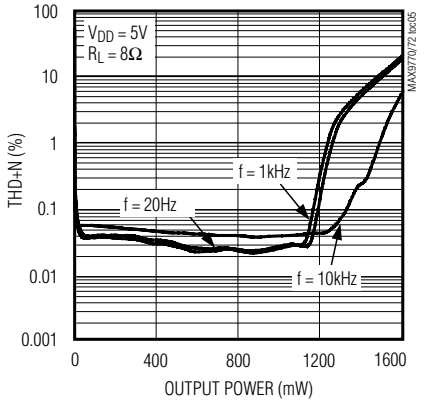


TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER (SPEAKER MODE)



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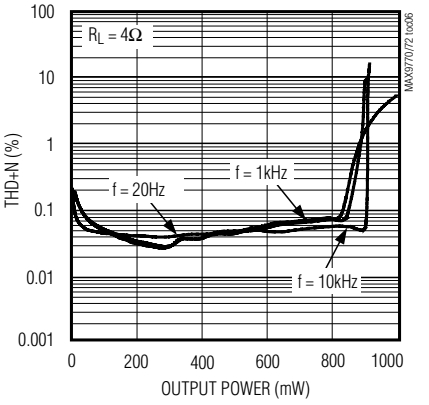
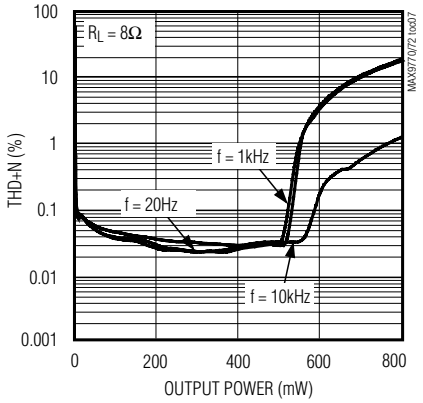
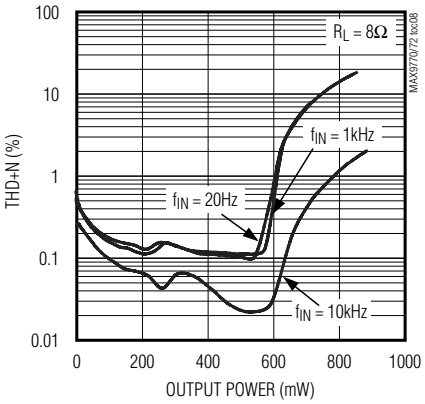


MAX9772

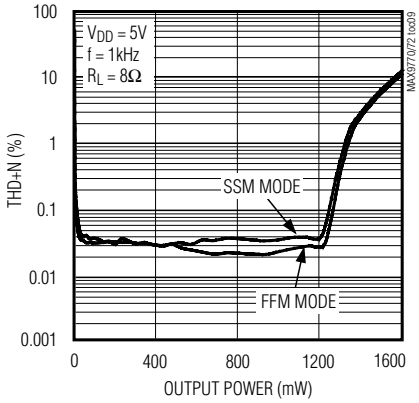
TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER (SPEAKER MODE)



TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER (SPEAKER MODE)



TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER (SPEAKER MODE)

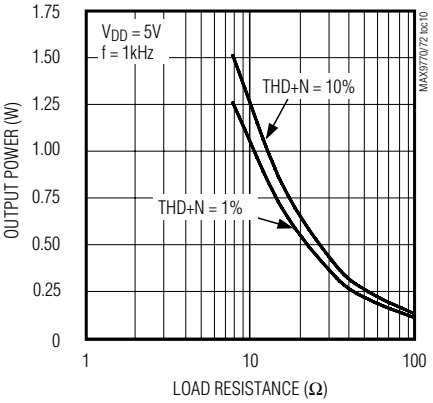


1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

Typical Operating Characteristics (continued)

(MAX9770 V_{DD} = 3.3V, BW = 22Hz to 22kHz, GAIN1 = 1, GAIN2 = 0, spread-spectrum mode, headphone outputs in phase, unless otherwise noted.)

OUTPUT POWER vs. LOAD RESISTANCE (SPEAKER MODE)



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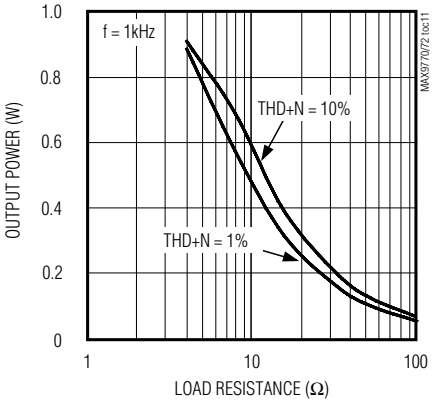
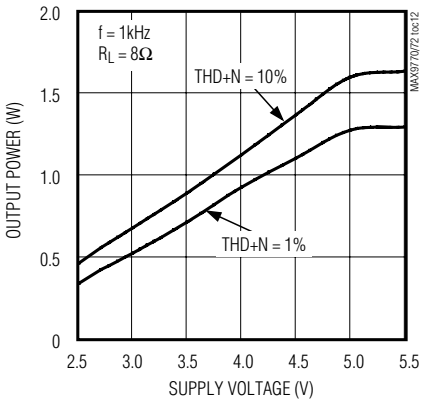
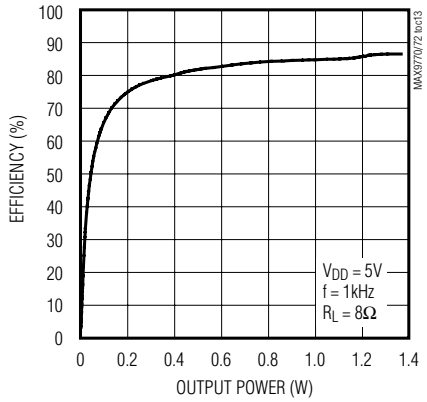


OUTPUT POWER vs. SUPPLY VOLTAGE (SPEAKER MODE)



EFFICIENCY vs. OUTPUT POWER



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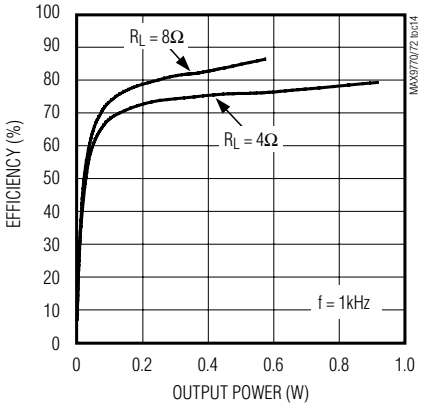
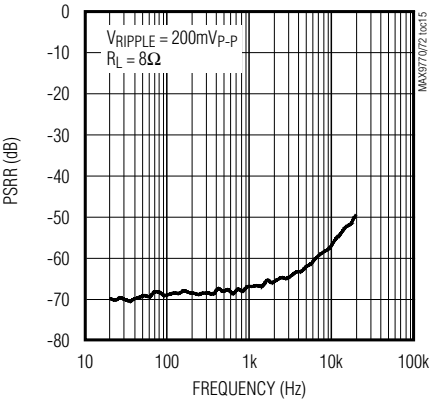
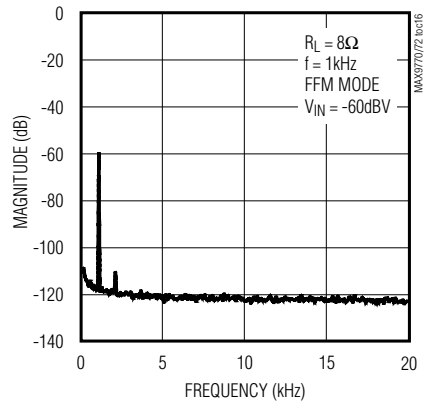


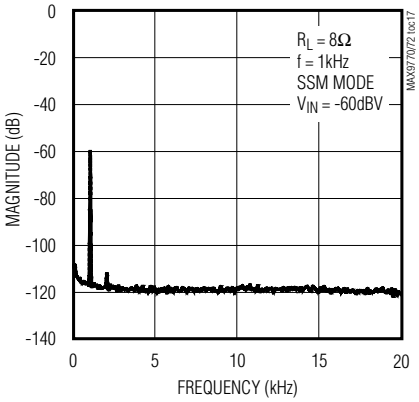
POWER-SUPPLY REJECTION RATIO vs. FREQUENCY (SPEAKER MODE)



OUTPUT SPECTRUM (SPEAKER MODE)



OUTPUT SPECTRUM (SPEAKER MODE)



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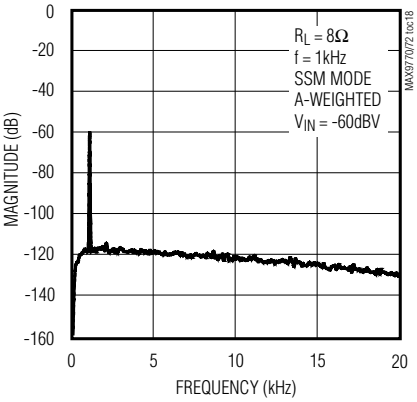
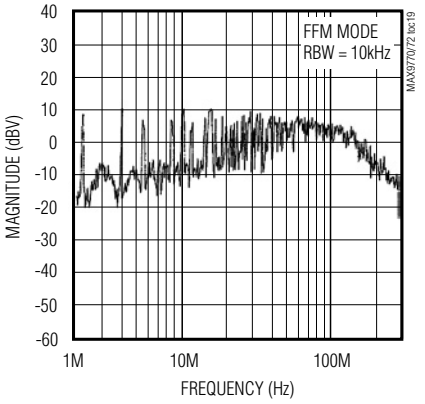


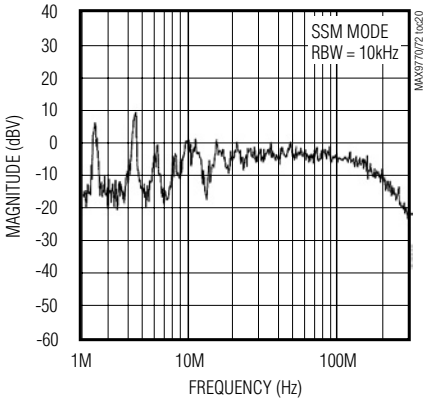
Typical Operating Characteristics (continued)

(MAX9770 V_{DD} = 3.3V, BW = 22Hz to 22kHz, GAIN1 = 1, GAIN2 = 0, spread-spectrum mode, headphone outputs in phase, unless otherwise noted.)

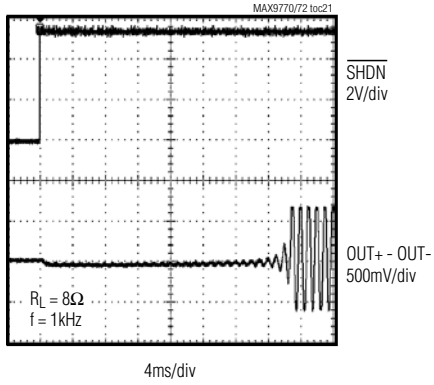
WIDEBAND OUTPUT SPECTRUM (SPEAKER MODE)



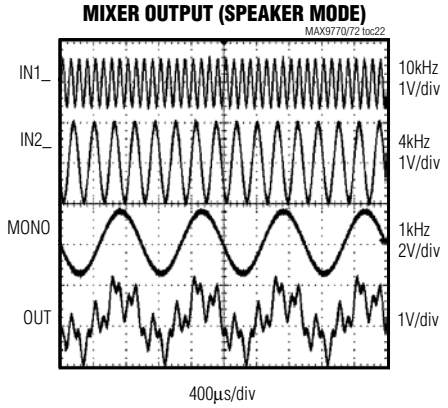
WIDEBAND OUTPUT SPECTRUM (SPEAKER MODE)



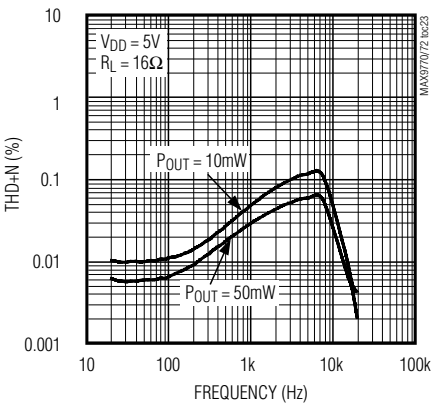
STARTUP WAVEFORM (SPEAKER MODE)



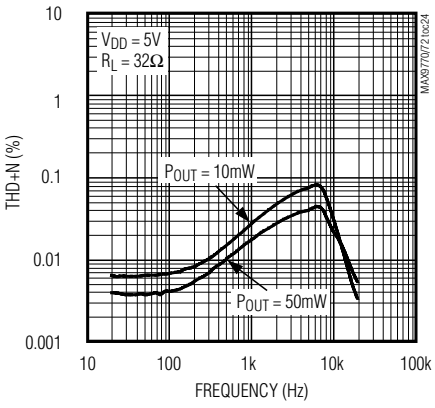
MAX9770 MIXER OUTPUT (SPEAKER MODE)



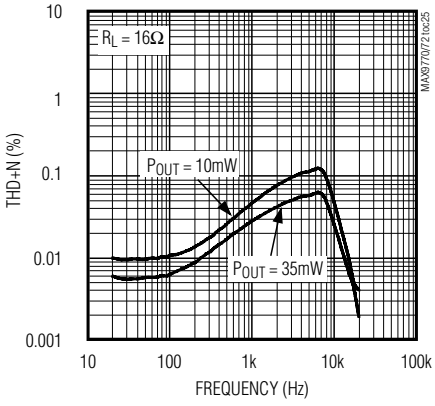
TOTAL HARMONIC DISTORTION PLUS NOISE vs. FREQUENCY (HEADPHONE MODE)



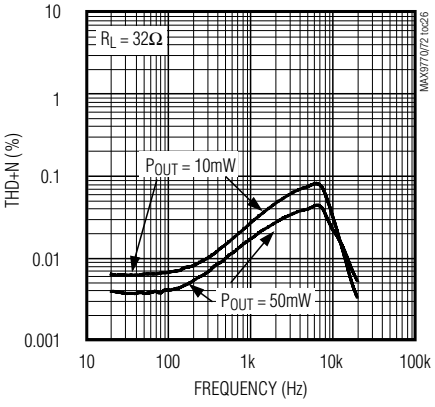
TOTAL HARMONIC DISTORTION PLUS NOISE vs. FREQUENCY (HEADPHONE MODE)



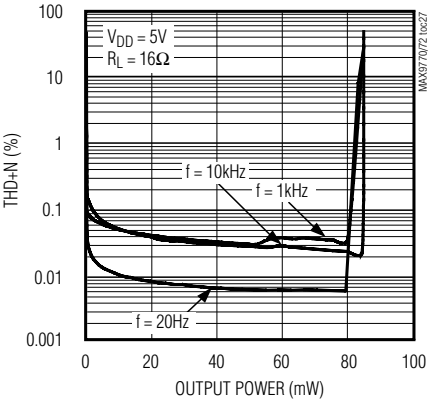
TOTAL HARMONIC DISTORTION PLUS NOISE vs. FREQUENCY (HEADPHONE MODE)



TOTAL HARMONIC DISTORTION PLUS NOISE vs. FREQUENCY (HEADPHONE MODE)



TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER (HEADPHONE MODE)

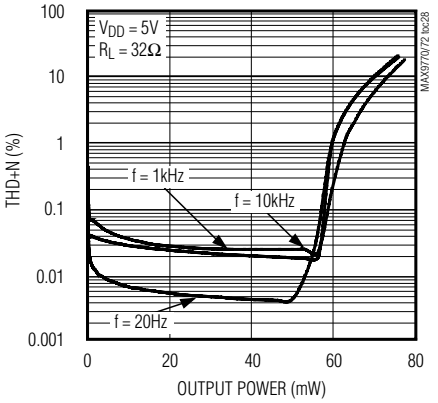


1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

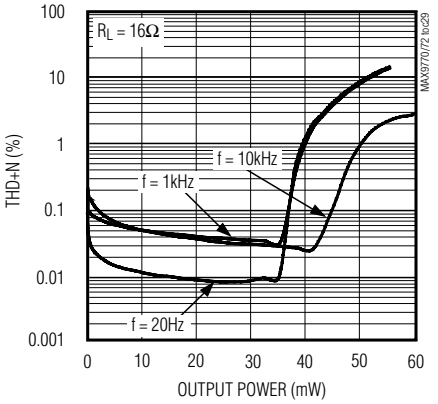
Typical Operating Characteristics (continued)

(MAX9770 V_{DD} = 3.3V, BW = 22Hz to 22kHz, GAIN1 = 1, GAIN2 = 0, spread-spectrum mode, headphone outputs in phase, unless otherwise noted.)

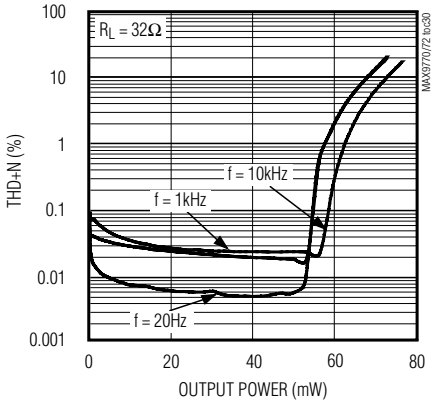
TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER (HEADPHONE MODE)



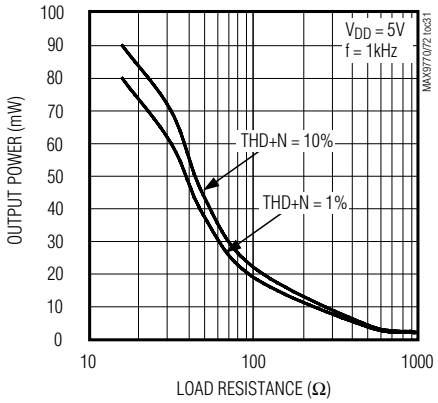
TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER (HEADPHONE MODE)



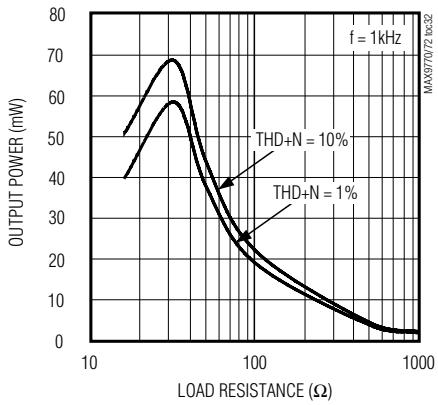
TOTAL HARMONIC DISTORTION PLUS NOISE vs. OUTPUT POWER (HEADPHONE MODE)



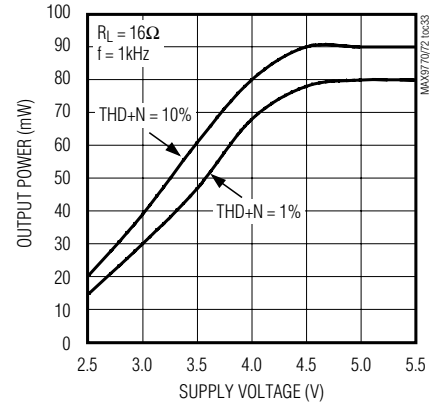
OUTPUT POWER vs. LOAD RESISTANCE (HEADPHONE MODE)



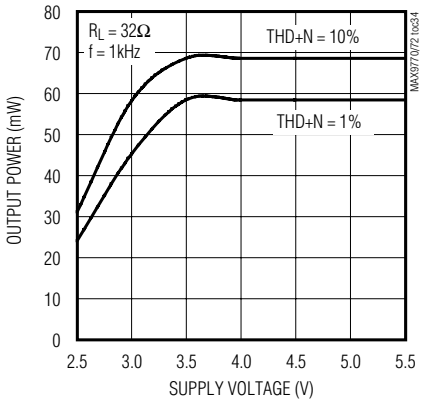
OUTPUT POWER vs. LOAD RESISTANCE (HEADPHONE MODE)



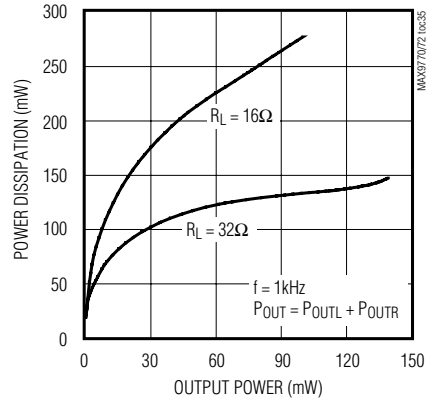
OUTPUT POWER vs. SUPPLY VOLTAGE (HEADPHONE MODE)



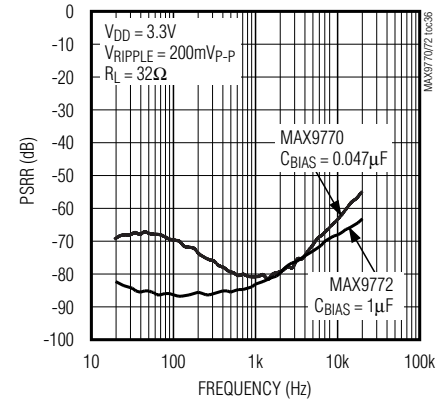
OUTPUT POWER vs. SUPPLY VOLTAGE (HEADPHONE MODE)



POWER DISSIPATION vs. OUTPUT POWER (HEADPHONE MODE)



POWER-SUPPLY REJECTION RATIO vs. FREQUENCY (HEADPHONE MODE)

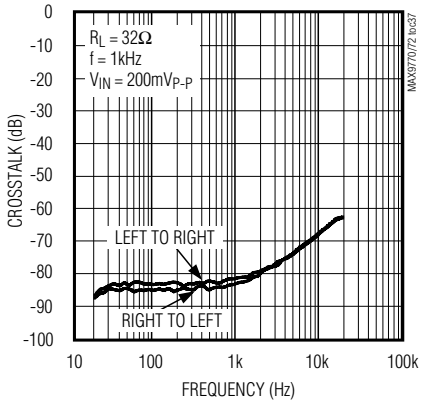


1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

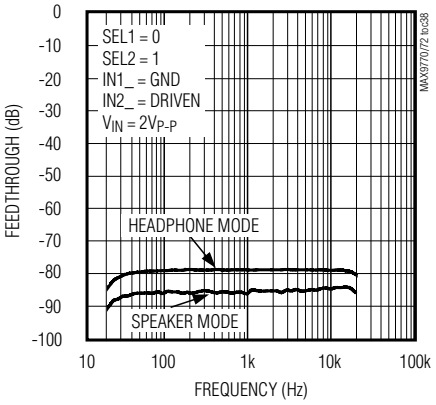
Typical Operating Characteristics (continued)

(MAX9770 V_{DD} = 3.3V, BW = 22Hz to 22kHz, GAIN1 = 1, GAIN2 = 0, spread-spectrum mode, headphone outputs in phase, unless otherwise noted.)

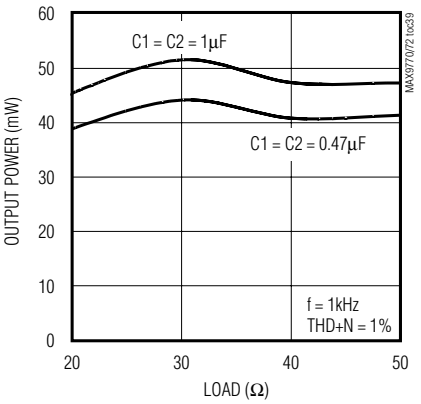
CROSSTALK vs. FREQUENCY (HEADPHONE MODE)



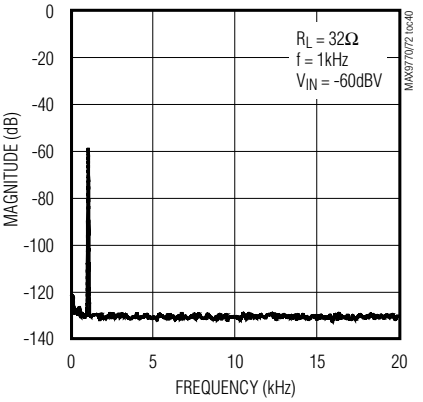
FEEDTHROUGH vs. FREQUENCY



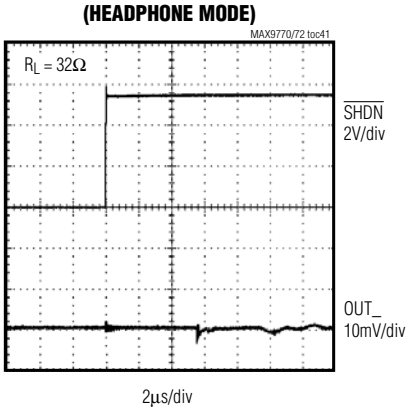
OUTPUT POWER vs. CHARGE-PUMP CAPACITANCE



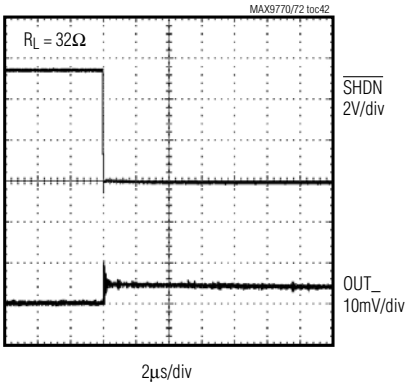
OUTPUT SPECTRUM (HEADPHONE MODE)



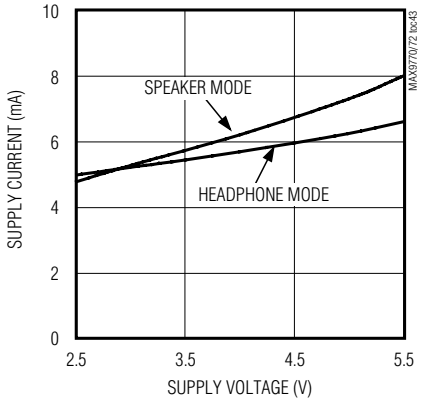
EXITING SHUTDOWN (HEADPHONE MODE)



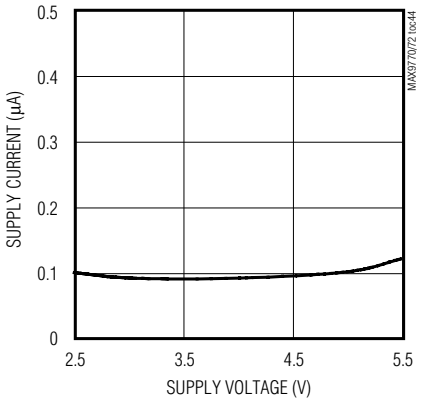
ENTERING SHUTDOWN (HEADPHONE MODE)



SUPPLY CURRENT vs. SUPPLY VOLTAGE



SHUTDOWN SUPPLY CURRENT vs. SUPPLY VOLTAGE



1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

Pin Description

PIN			NAME	FUNCTION
TQFN	TSSOP	UCSP		
1	4	A2	BIAS	Common-Mode Bias Voltage. Bypass with a 0.047µF capacitor to GND.
2	5	A4	V_{DD}	Power Supply
3	6	A5	HPOUTR	Right-Channel Headphone Output
4	7	B4	HPOUTL	Left-Channel Headphone Output
5	8	B5*	SV_{SS}	Headphone Amplifier Negative Power Supply
6	9	A3	HPS	Headphone Sense Input
7	10	E4	CPV_{DD}	Positive Charge-Pump Power Supply
8	11	B5*	CPV_{SS}	Charge-Pump Output. Connect to SV_{SS}.
9	12	C5	C1N	Charge-Pump Flying Capacitor Negative Terminal
10	13	E5	C1P	Charge-Pump Flying Capacitor Positive Terminal
11	14	D5	CPGND	Charge-Pump Ground
12	15	C4	SEL1	Select Stereo Channel 1 Inputs. Digital input. Drive SEL1 high to select inputs IN1L and IN1R.
13	16	—	SEL2	Select Stereo Channel 2 Inputs. Digital input. Drive SEL2 high to select inputs IN2L and IN2R.
14	17	D4	SELM	Select Mono Channel Input. Digital input. Drive SELM high to select the MONO input.
15	18	C2	$\overline{SHDN}$	Shutdown. Drive $\overline{SHDN}$ low to disable the device. Connect $\overline{SHDN}$ to V_{DD} for normal operation.
16	19	D3	SYNC	Frequency Select and External Clock Input: **SYNC = GND:** fixed-frequency PWM mode with f_S = 1100kHz. **SYNC = Float:** fixed-frequency PWM mode with f_S = 1450kHz. **SYNC = V_{DD}:** spread-spectrum PWM mode with f_S = 1220kHz ±120kHz. **SYNC = Clocked:** fixed-frequency PWM mode with f_S = external clock frequency.
17	20	D1, D2	PGND	Speaker Amplifier Power Ground
18	21	E1	OUT+	Speaker Amplifier Positive Output
19	22	E3	OUT-	Speaker Amplifier Negative Output
20	23	E2	PV_{DD}	Speaker Amplifier Power Supply
21	24	B3	GAIN2	Gain Control Input 2
22	25	C3	GAIN1	Gain Control Input 1
23	26	A1	MONO	Mono Channel Input
24	27	—	IN2L	Stereo Channel 2, Left Input
25	28	B1	IN1L	Stereo Channel 1, Left Input
26	1	C1	GND	Ground
27	2	—	IN2R	Stereo Channel 2, Right Input
28	3	B2	IN1R	Stereo Channel 1, Right Input
EP	—	—	EP	Exposed Paddle. Can be left floating or tied to GND.

**SV_{SS} and CPV_{SS} are internally connected to the same bump on the MAX9772.*

1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

Detailed Description

The MAX9770/MAX9772 combine mono 1.2W Class D speaker amplifiers and stereo 80mW DirectDrive headphone amplifiers with integrated headphone sensing and comprehensive click-and-pop suppression. A mixer/multiplexer allows for selection and mixing between two stereo input sources and a single mono source (MAX9770) or a single stereo input source and a single mono source (MAX9772). The MAX9770/MAX9772 feature PSRR as high as 85dB, THD as low as 0.015%, industry-leading click-and-pop suppression, and a low-power shutdown mode.

Class D Speaker Amplifier

The MAX9770/MAX9772 Class D amplifiers feature true filterless, low-EMI, switch-mode architecture that provides Class AB-like performance with Class D efficiency. Comparators monitor the MAX9770/MAX9772 input and compare the input voltage to a sawtooth waveform. The comparators trip when the input magnitude of the sawtooth exceeds the corresponding input voltage. The comparator resets at a fixed time after the rising edge of the second comparator trip point, generating a minimum-width pulse $t_{ON(min)}$ at the output of the second comparator (Figure 1). As the input voltage increases or decreases, the duration of the pulse at one output increases (the first comparator trip point) while the other output pulse duration remains at $t_{ON(min)}$. This causes the net voltage across the speaker (V_{OUT+} - V_{OUT-}) to change.

Table 1. Operating Modes

SYNC INPUT	MODE
GND	FFPWM with f_S = 1100kHz
FLOAT	FFPWM with f_S = 1450kHz
V_{DD}	SSPWM with f_S = 1220kHz ±120kHz
Clocked	FFPWM with f_S = external clock frequency

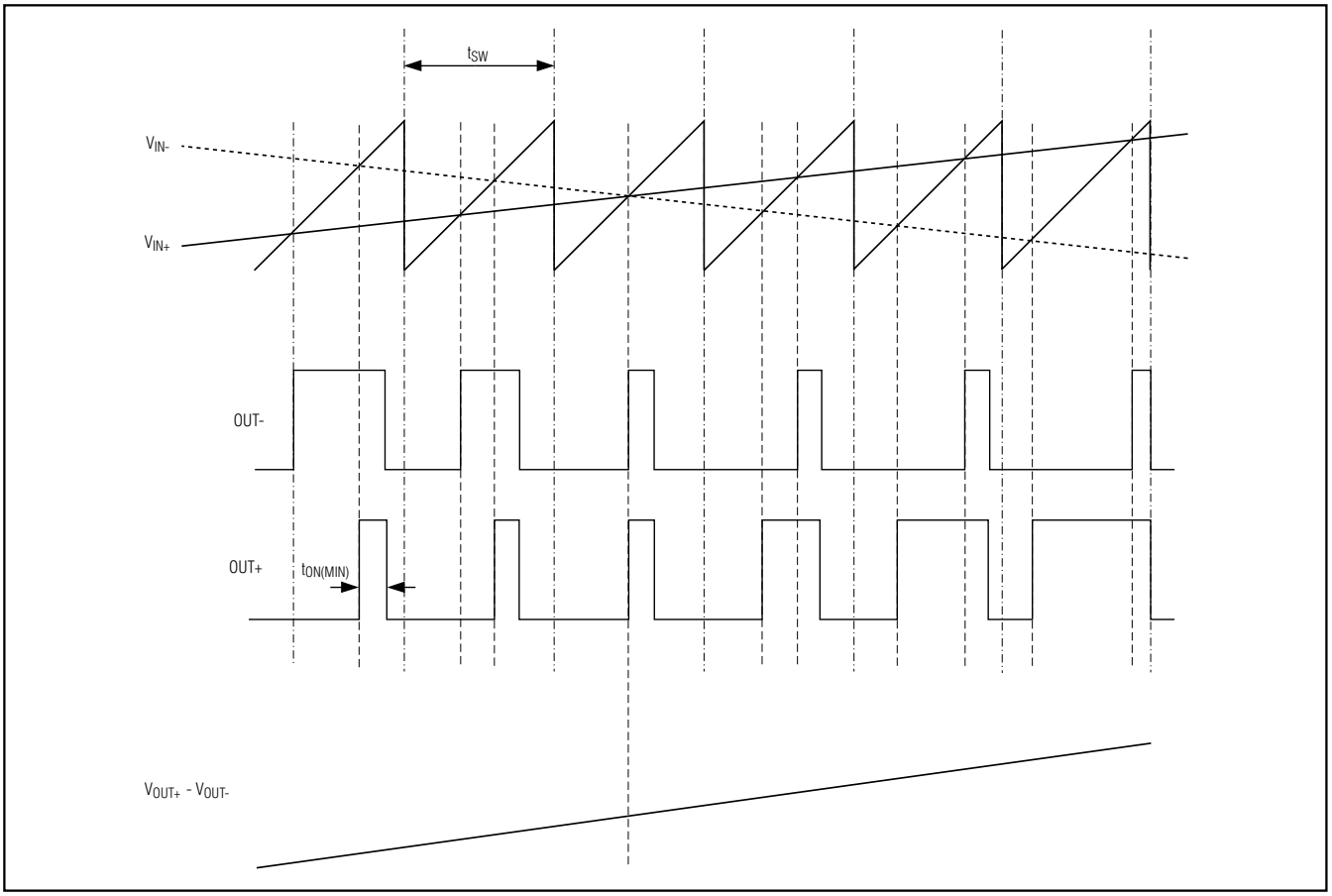


Figure 1. MAX9770/MAX9772 Outputs with an Input Signal Applied

1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

Operating Modes

The switching frequency of the charge pump is 1/2 the switching frequency of the Class D amplifier, regardless of the operating mode. When SYNC is driven externally, the charge pump switches at 1/2 f_{SYNC}. When SYNC = V_{DD}, the charge pump switches with a spread-spectrum pattern.

Fixed-Frequency Modulation (FFM) Mode

The MAX9770/MAX9772 feature two FFM modes. The FFM modes are selected by setting SYNC = GND for a 1.1MHz switching frequency, and SYNC = FLOAT for a 1.45MHz switching frequency. In FFM mode, the frequency spectrum of the Class D output consists of the fundamental switching frequency and its associated harmonics (see the Wideband FFT graph in the *Typical Operating Characteristics*). The MAX9770/MAX9772 allow the switching frequency to be changed by +32% should the frequency of one or more harmonics fall in a sensitive band. This can be done during operation and does not affect audio reproduction.

Spread-Spectrum Modulation (SSM) Mode

The MAX9770/MAX9772 feature a unique, patented spread-spectrum mode that flattens the wideband spectral components, improving EMI emissions radiated by the speaker and cables by 5dB. Proprietary techniques ensure that the cycle-to-cycle variation of the switching period does not degrade audio reproduction or efficiency (see the *Typical Operating Characteristics*). Select SSM mode by setting SYNC = V_{DD}. In SSM mode, the switching frequency varies randomly by ±120kHz around the center frequency (1.22MHz). The modulation scheme remains the same, but the period of the sawtooth waveform changes from cycle-to-cycle (Figure 2). Instead of a large amount of spectral energy present at multiples of the switching frequency, the energy is now spread over a bandwidth that increases with frequency. Above a few MHz, the wideband spectrum looks like white noise for EMI purposes (Figure 3).

External Clock Mode

The SYNC input allows the MAX9770/MAX9772 to be synchronized to a system clock (allowing a fully synchronous system), or allocating the spectral components of the switching harmonics to insensitive frequency bands. Applying an external clock of 800kHz to 2MHz to SYNC synchronizes the switching frequency of both the Class D and charge pump. The period of the SYNC clock can be randomized, enabling the MAX9770/MAX9772 to be synchronized to another spread-spectrum Class D amplifier operating in SSM mode.

Filterless Modulation/Common-Mode Idle

The MAX9770/MAX9772 use Maxim's unique, patented modulation scheme that eliminates the LC filter required by traditional Class D amplifiers, improving efficiency, reducing component count, conserving board space and system cost. Conventional Class D amplifiers output a 50% duty cycle square wave when no signal is present. With no filter, the square wave appears across the load as a DC voltage, resulting in finite load current, increasing power consumption. When no signal is present at the device input, the outputs switch as shown in Figure 4. Because the MAX9770/MAX9772 drive the speaker differentially, the two outputs cancel each other, resulting in no net idle mode voltage across the speaker, minimizing power consumption.

Efficiency

The efficiency of a Class D amplifier is attributed to the region of operation of the output stage transistors. In a Class D amplifier, the output transistors act as current-steering switches and consume negligible additional power. Any power loss associated with the Class D output stage is mostly due to the I*R loss of the MOSFET on-resistance, and quiescent current overhead.

The theoretical best efficiency of a linear amplifier is 78%; however, that efficiency is only exhibited at peak output powers. Under normal operating levels (typical music reproduction levels), efficiency falls below 30%, whereas the MAX9770/MAX9772 still exhibit >80% efficiencies under the same conditions (Figure 5).

DirectDrive

Traditional single-supply headphone drivers have their outputs biased about a nominal DC voltage (typically half the supply) for maximum dynamic range. Large coupling capacitors are needed to block this DC bias from the headphone. Without these capacitors, a significant amount of DC current flows to the headphone, resulting in unnecessary power dissipation and possible damage to both headphone and headphone driver.

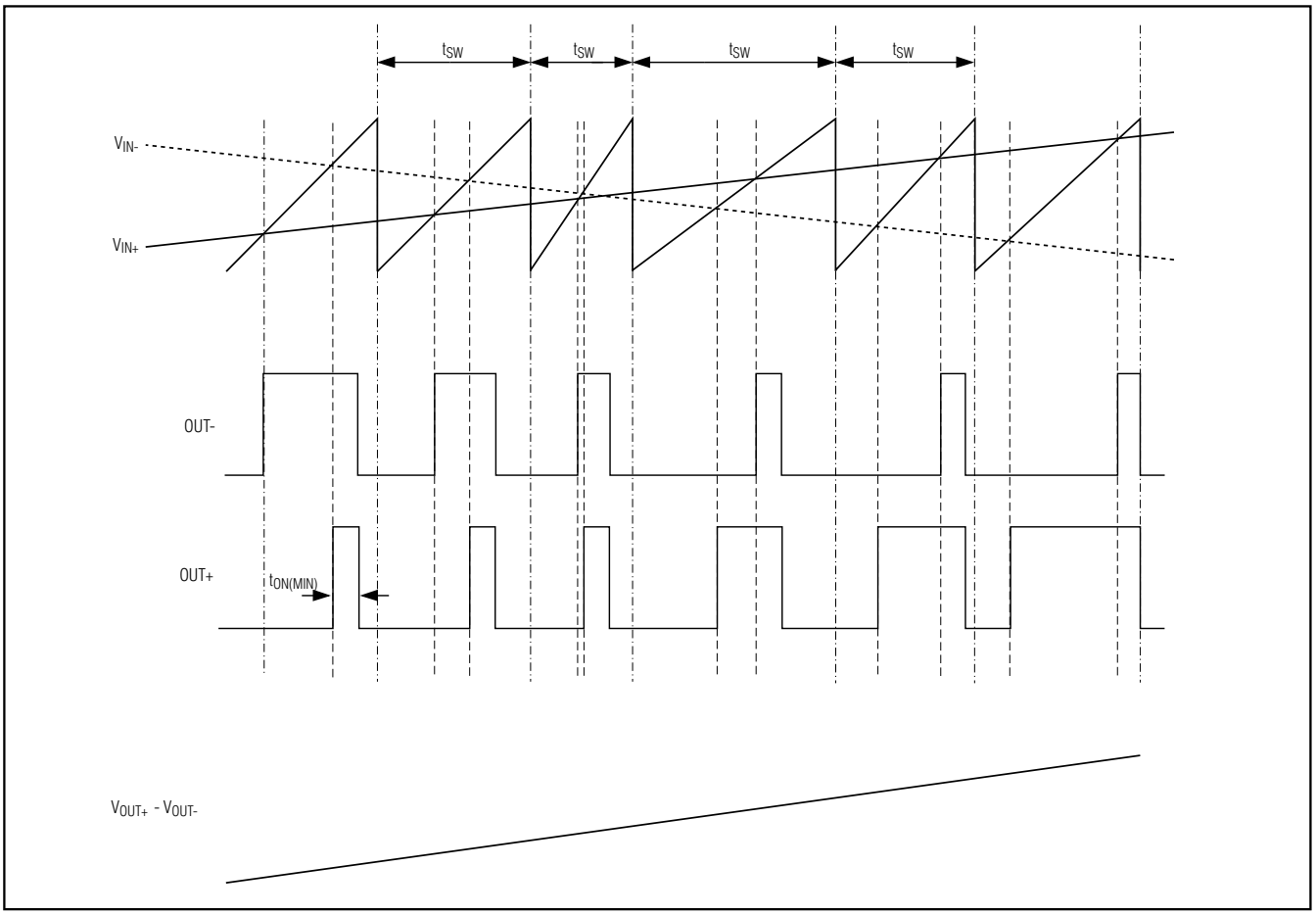


Figure 2. MAX9770/MAX9772 Output with an Input Signal Applied (SSM Mode)

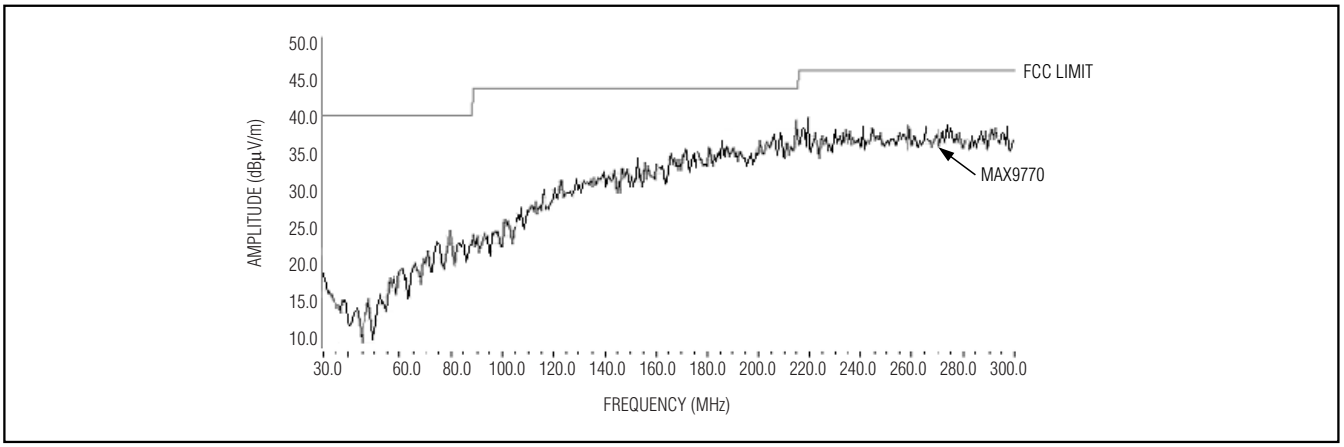


Figure 3. MAX9770 EMI with 75mm of Speaker Cable

1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

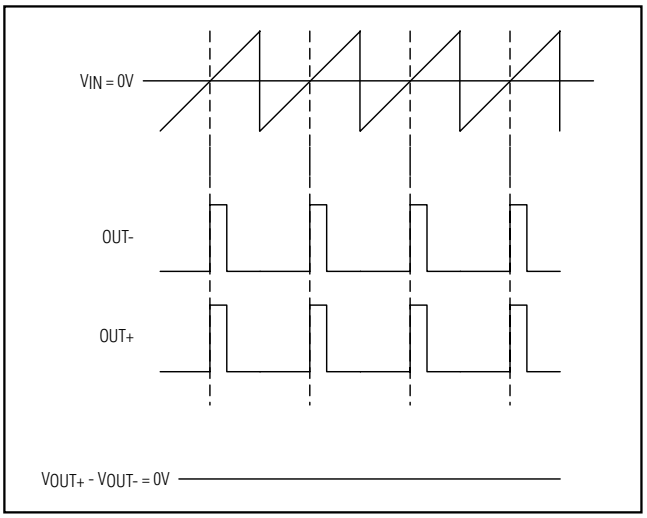


Figure 4. MAX9770/MAX9772 Output with No Signal Applied

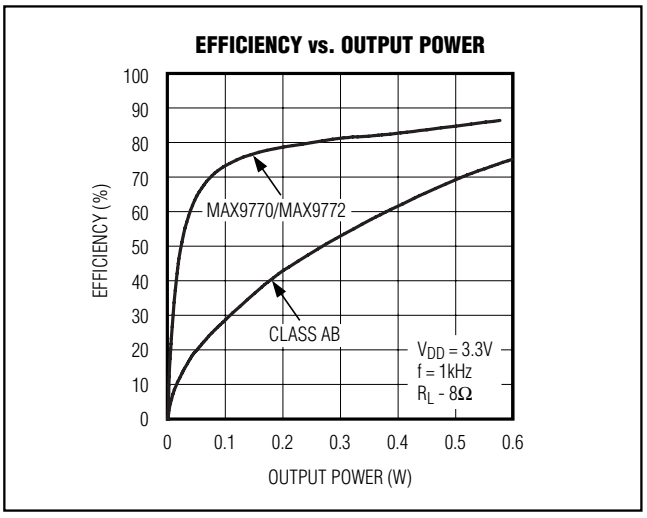


Figure 5. MAX9770/MAX9772 Efficiency vs. Class AB Efficiency

Maxim's patented DirectDrive architecture uses a charge pump to create an internal negative supply voltage. This allows the headphone outputs of the MAX9770/MAX9772 to be biased about GND, almost doubling dynamic range while operating from a single supply. With no DC component, there is no need for the large DC-blocking capacitors. Instead of two large (220µF, typ) tantalum capacitors, the MAX9770/MAX9772 charge pump requires two small ceramic capacitors, which conserves board space, reduces cost, and improves the frequency response of the headphone driver. See the Output Power vs. Charge-Pump Capacitance and Load Resistance graph in the *Typical Operating Characteristics* for details of the possible capacitor sizes. There is a low DC voltage on the driver outputs due to amplifier offset. However, the offset of the MAX9770/MAX9772 is typically 5mV, which, when combined with a 32Ω load, results in less than 160µA of DC current flow to the headphones.

In addition to the cost and size disadvantages of the DC-blocking capacitors required by conventional headphone amplifiers, these capacitors limit the amplifier's low-frequency response and can distort the audio signal.

Previous attempts at eliminating the output-coupling capacitors involved biasing the headphone return (sleeve) to the DC bias voltage of the headphone amplifiers. This method raises some issues:

1) When combining a microphone and headphone on a single connector, the microphone bias scheme typically requires a 0V reference.

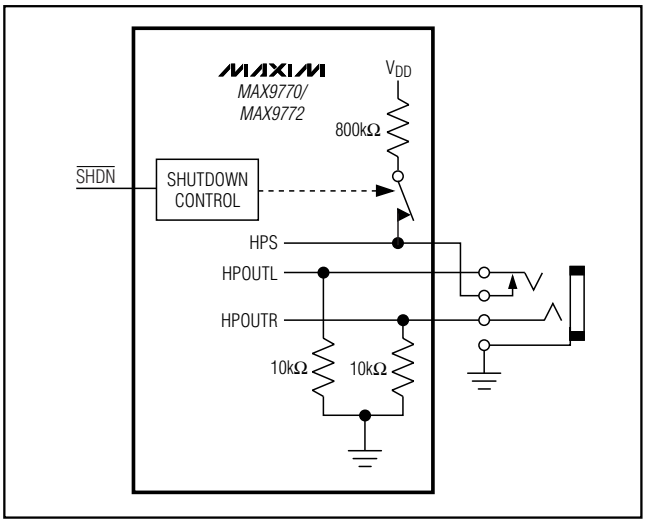


Figure 6. HPS Configuration

2) The sleeve is typically grounded to the chassis. Using the midrail biasing approach, the sleeve must be isolated from system ground, complicating product design.

3) During an ESD strike, the driver's ESD structures are the only path to system ground. Thus, the driver must be able to withstand the full ESD strike.

4) When using the headphone jack as a line out to other equipment, the bias voltage on the sleeve may conflict with the ground potential from other equipment, resulting in possible damage to the drivers.

Table 2. MAX9770 Multiplexer/Mixer Settings

SEL1	SEL2	SELM	HEADPHONE MODE		SPEAKER MODE
			HPOUTL	HPOUTR	
0	0	0	MUTE	MUTE	MUTE
1	0	0	IN1L	IN1R	(IN1L + IN1R) / 2
0	1	0	IN2L	IN2R	(IN2L + IN2R) / 2
0	0	1	MONO	MONO	MONO
1	1	0	(IN1L + IN2L) / 2	(IN1R + IN2R) / 2	(IN1L + IN1R + IN2L + IN2R) / 4
1	0	1	(IN1L + MONO) /2	(IN1R + MONO) / 2	(IN1L + IN1R + MONO x 2) / 4
0	1	1	(IN2L + MONO) / 2	(IN2R + MONO) / 2	(IN2L + IN2R + MONO x 2) / 4
1	1	1	(IN1L + IN2L + MONO) / 3	(IN1R + IN2R + MONO) / 3	(IN1L + IN1R + IN2L + IN2R + MONO x 2) / 6

Table 3. MAX9772 Multiplexer/Mixer Settings

SEL1	SELM	HEADPHONE MODE		SPEAKER MODE
		HPOUTL	HPOUTR	
0	0	MUTE	MUTE	MUTE
1	0	IN1L	IN1R	(IN1L + IN1R) / 2
0	1	MONO	MONO	MONO
1	1	(IN1L + MONO) /2	(IN1R + MONO) /2	(IN1L + IN1R + MONO x 2) / 4

Charge Pump

The MAX9770/MAX9772 feature low-noise charge pumps. The switching frequency of the charge pump is 1/2 the switching frequency of the Class D amplifier, regardless of the operating mode. When SYNC is driven externally, the charge pumps switch at 1/2 f_{SYNC}. When SYNC = V_{DD}, the charge pumps switch with a spread-spectrum pattern. The nominal switching frequency is well beyond the audio range, and thus does not interfere with the audio signals, resulting in an SNR of 101dB. The switch drivers feature a controlled switching speed that minimizes noise generated by turn-on and turn-off transients. By limiting the switching speed of the charge pumps, the di/dt noise caused by the parasitic bond wire and trace inductance is minimized. Although not typically required, additional high-frequency noise attenuation can be achieved by increasing the size of C2 (see *Typical Application Circuit*). The charge pumps are active in both speaker and headphone modes.

Input Multiplexer/Mixer

The MAX9770/MAX9772 feature input multiplexers/mixers that allow multiple audio sources to be selected/mixed. Driving a SEL_ input high selects the input channel (see Tables 2 and 3), and the audio signal is output to the active amplifier. When a stereo path is selected in speaker mode, the left and right inputs are attenuated by 6dB and mixed together, resulting in a true mono reproduction of a stereo signal. When more than one signal path is selected, the sources are attenuated before mixing to preserve overall amplitude. For example, selecting two sources in headphone mode results in 6dB attenuation of the inputs, while selecting three sources (MAX9770) in headphone mode results in 9.5dB attenuation of the inputs. Tables 2 and 3 show how the input signals are attenuated and mixed for each possible input selection combination.

Headphone Sense Input (HPS)

The headphone sense input (HPS) monitors the headphone jack, and automatically configures the device based upon the voltage applied at HPS. A voltage of less than 0.8V sets the device to speaker mode. A voltage of greater than 2V disables the bridge amplifiers and enables the headphone amplifiers.

For automatic headphone detection, connect HPS to the control pin of a 3-wire headphone jack as shown in Figure 6. With no headphone present, the output impedance of the headphone amplifier pulls HPS to less than 0.8V. When a headphone plug is inserted into the jack, the control pin is disconnected from the tip contact and HPS is pulled to V_{DD} through the internal 800kΩ pullup. When driving HPS from an external logic source, ground HPS when the MAX9770/MAX9772 are shut down. Place a 10kΩ resistor in series with HPS and the headphone jack to ensure ±8kV ESD protection.

1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

Table 4. Gain Selection

GAIN1	GAIN2	MAX9770 SPEAKER GAIN (dB)	MAX9772 SPEAKER GAIN (dB)	HEADPHONE GAIN (dB)
0	0	6	15.6	7
0	1	3	12	4
1	0	9	20	-2
1	1	0	6	1

Table 5. Gain Settings with HPS Connection

GAIN1	GAIN2	MAX9770 SPEAKER MODE GAIN (HPS = 0) (dB)	MAX9772 SPEAKER MODE GAIN (HPS = 0) (dB)	HEADPHONE MODE GAIN (HPS = 1) (dB)
HPS	0	6	15.6	-2
HPS	1	3	12	1
0	HPS	6	15.6	4
1	HPS	9	20	1
HPS	HPS	6	15.6	1
0	0	6	15.6	7
0	1	3	12	4
1	0	9	20	-2
1	1	0	6	1

BIAS

The MAX9770/MAX9772 feature internally generated, power-supply independent, common-mode bias voltages referenced to GND. BIAS provides both click-and-pop suppression and sets the DC bias level for the amplifiers. Choose the value of the bypass capacitor as described in the *BIAS Capacitor* section. No external load should be applied to BIAS. Any load lowers the BIAS voltage, affecting the overall performance of the device.

Gain Selection

The MAX9770/MAX9772 feature logic-selectable, internally set gains. GAIN1 and GAIN2 set the gain of the MAX9770/MAX9772 speaker and headphone amplifiers as shown in Table 4.

The MAX9770/MAX9772 can be configured to automatically switch between two gain settings depending on whether the device is in speaker or headphone mode. By driving one or both gain inputs with HPS, the gain of the device changes when a headphone is inserted or removed. For example, the block diagram shows HPS connected to GAIN2, while GAIN1 is connected to V_{DD}. In this configuration, the gain in speaker mode is 9dB, while the gain in headphone mode is 1dB. The gain settings with the HPS connection are shown in Table 5.

Shutdown

The MAX9770/MAX9772 feature a 0.1µA, low-power shutdown mode that reduces quiescent current consumption and extends battery life. Drive $\overline{SHDN}$ low to disable the drive amplifiers, bias circuitry, and charge pump. Bias is driven to GND and the headphone amplifier output impedance is 10kΩ in shutdown. Connect $\overline{SHDN}$ to V_{DD} for normal operation.

Click-and-Pop Suppression

Speaker Amplifier

The MAX9770/MAX9772 speaker amplifiers feature comprehensive click-and-pop suppression that eliminates audible transients on startup and shutdown. While in shutdown, the H-bridge is in a high-impedance state. During startup or power-up, the input amplifiers are muted and an internal loop sets the modulator bias voltages to the correct levels, preventing clicks and pops when the H-bridge is subsequently enabled. A soft-start function unmutes the input amplifiers 30ms after startup.

Headphone Amplifier

In conventional single-supply headphone drivers, the output-coupling capacitor is a major contributor of audible clicks and pops. Upon startup, the driver charges the coupling capacitor to its bias voltage, typically half the supply. Likewise, during shutdown, the capacitor is discharged to GND. This results in a DC shift across the capacitor, which in turn, appears as an audible transient at the speaker. Since the MAX9770/MAX9772 headphone amplifiers do not require output-coupling capacitors, this does not arise.

Additionally, the MAX9770/MAX9772 feature extensive click-and-pop suppression that eliminates any audible transient sources internal to the device. The Power-Up/Power-Down Waveform in the *Typical Operating Characteristics* shows that there are minimal spectral components in the audible range at the output upon startup or shutdown.

In most applications, the output of the preamplifier driving the MAX9770/MAX9772 has a DC bias of typically half the supply. During startup, the input-coupling capacitor is charged to the preamplifier's DC bias voltage through the R_F of the MAX9770/MAX9772, resulting in a DC shift across the capacitor and an audible click-and-pop. An internal delay of 50ms eliminates the click-and-pop caused by the input filter.

Applications Information

Filterless Operation

Traditional Class D amplifiers require an output filter to recover the audio signal from the amplifier's output. The filters add cost, increase the solution size of the amplifier, and can decrease efficiency. The traditional PWM scheme uses large differential output swings (2 x V_{DD} peak-to-peak) at idle and causes large ripple currents. Any parasitic resistance in the filter components results in a loss of power, lowering efficiency.

The MAX9770/MAX9772 do not require an output filter. The devices rely on the inherent inductance of the speaker coil and the natural filtering of both the speaker and the human ear to recover the audio component of the square-wave output. Eliminating the output filter results in a smaller, less costly, and more efficient solution.

Because the frequency of the MAX9770/MAX9772 output is well beyond the bandwidth of most speakers, voice coil movement due to the square-wave frequency is minimal. Although this movement is small, a speaker not designed to handle the additional power may be damaged. For optimum results, use a speaker with a series inductance >10µH. Typical small 8Ω speakers exhibit series inductances in the range of 20µH to 100µH.

Output Offset

Unlike Class AB amplifiers, the output offset voltage of a Class D amplifier does not noticeably increase quiescent current draw when a load is applied. This is due to the power conversion of the Class D amplifier. For example, a 15mV DC offset across an 8Ω load results in 1.9mA extra current consumption in a Class AB device. In the Class D case, a 15mV offset into 8Ω equates to an additional power drain of 28µW. Due to the high efficiency of the Class D amplifier, this represents an additional quiescent current draw of 28µW/(V_{DD} / 100 x η), which is on the order of a few microamps.

Power Supplies

The MAX9770/MAX9772 have different supplies for each portion of the device, allowing for the optimum combination of headroom and power dissipation and noise immunity. The speaker amplifiers are powered from PV_{DD}. PV_{DD} ranges from 2.5V to 5.5V. The headphone amplifiers are powered from V_{DD} and SV_{SS}. V_{DD} is the positive supply of the headphone amplifiers and ranges from 2.5V to 5.5V. SV_{SS} is the negative supply of the headphone amplifiers. Connect SV_{SS} to CPV_{SS}. The charge pump is powered by CPV_{DD}. CPV_{DD} ranges from 2.5V to 5.5V and should be the same potential as V_{DD}. The charge pump inverts the voltage at CPV_{DD}, and the resulting voltage appears at CPV_{SS}. The remainder of the device is powered by V_{DD}.

Component Selection

Input Filter

The input capacitor (C_{IN}), in conjunction with the amplifier input resistance (R_{IN}), forms a highpass filter that removes the DC bias from an incoming signal (see the *Typical Application Circuit*). The AC-coupling capacitor allows the amplifier to bias the signal to an optimum DC level. Assuming zero-source impedance, the -3dB point of the highpass filter is given by:

$$f_{-3dB} = \frac{1}{2\pi R_{IN} C_{IN}}$$

R_{IN} is the amplifier's internal input resistance value given in the *Electrical Characteristics*. Be aware that the MONO input has a lower input impedance than the other inputs. Choose C_{IN} such that f_{-3dB} is below the lowest frequency of interest. Setting f_{-3dB} too high affects the amplifier's low-frequency response. Setting f_{-3dB} too low can affect the click-and-pop performance. Use capacitors with low-voltage coefficient dielectrics, such as tantalum or aluminum electrolytic. Capacitors with high-voltage coefficients, such as ceramics, may result in increased distortion at low frequencies.

Output Filter

The MAX9770/MAX9772 speaker amplifiers do not require an output filter for normal operation and audio reproduction. The devices pass FCC Class B radiated emissions standards with 100mm of unshielded speaker cables. However, output filtering can be used if a design is failing radiated emissions due to board layout or cable length, or if the circuit is near EMI-sensitive devices. Use a common-mode choke connected in series with the speaker outputs if board space is limited and emissions are a concern. Use of an LC filter is necessary if excessive speaker cable is used.

BIAS Capacitor

BIAS is the output of the internally generated DC bias voltage. The BIAS bypass capacitor, C_{BIAS} improves PSRR and THD+N by reducing power supply and other noise sources at the common-mode bias node, and also generates the clickless/popless, startup/shutdown DC bias waveforms for the speaker amplifiers. Bypass BIAS with a 0.047µF capacitor to GND for the MAX9770 and a 1µF capacitor to GND for the MAX9772.

Table 6. Suggested Capacitor Manufacturers

SUPPLIER	PHONE	FAX	WEBSITE
Taiyo Yuden	800-348-2496	847-925-0899	www.t-yuden.com
TDK	807-803-6100	847-390-4405	www.component.tdk.com

Charge-Pump Capacitor Selection

Use capacitors with an ESR less than 100mΩ for optimum performance. Low-ESR ceramic capacitors minimize the output resistance of the charge pump. Most surface-mount ceramic capacitors satisfy the ESR requirement. For best performance over the extended temperature range, select capacitors with an X7R dielectric. Table 6 lists suggested manufacturers.

Flying Capacitor (C1)

The value of the flying capacitor (C1) affects the load regulation and output resistance of the charge pump. A C1 value that is too small degrades the device's ability to provide sufficient current drive, which leads to a loss of output voltage. Increasing the value of C1 may improve load regulation and reduces the charge-pump output resistance to an extent. Above 1µF, the on-resistance of the switches and the ESR of C1 and C2 dominate.

Output Capacitor (C2)

The output capacitor value and ESR directly affect the ripple at CPV_{SS}. Increasing the value of C2 reduces output ripple. Likewise, decreasing the ESR of C2 reduces both ripple and output resistance. Lower capacitance values can be used in systems with low maximum output power levels. See the Output Power vs. Charge-Pump Capacitance and Load Resistance graph in the *Typical Operating Characteristics*.

CPV_{DD} Bypass Capacitor

The CPV_{DD} bypass capacitor (C3) lowers the output impedance of the power supply and reduces the impact of the MAX9770/MAX9772s' charge-pump switching transients. Bypass CPV_{DD} with C3, the same value as C1, and place it physically close to the CPV_{DD} and PGND (refer to the MAX9770 EV kit for a suggested layout).

Layout and Grounding

Proper layout and grounding are essential for optimum performance. Use large traces for the power-supply inputs and amplifier outputs to minimize losses due to parasitic trace resistance, as well as route the head away from the device. Good grounding improves audio performance, minimizes crosstalk between channels, and prevents any switching noise from coupling into the audio signal. Connect CPGND, PGND, and GND together at a single point on the PC board. Route CPGND and all traces that carry switching transients away from GND, PGND, and the traces and components in the audio signal path.

Connect all components associated with the charge pump (C2 and C3) to the CPGND plane. Connect SV_{SS} and CPV_{SS} together at the device.* Place the charge-pump capacitors (C1, C2, and C3) as close to the device as possible. Bypass V_{DD} and PV_{DD} with a 1µF capacitor to GND. Place the bypass capacitors as close to the device as possible.

Use large, low-resistance output traces. As load impedance decreases, the current drawn from the device outputs increase. At higher current, the resistance of the output traces decrease the power delivered to the load. Large output, supply, and GND traces also improve the power dissipation of the device.

The MAX9770 thin QFN package features an exposed thermal pad on its underside. This pad lowers the package's thermal resistance by providing a direct heat conduction path. Due to the high efficiency of the MAX9770's Class D amplifier, additional heatsinking is not required. If additional heatsinking is required, connect the exposed paddle to GND. See the MAX9770 EV kit data sheet for suggested component values and layout guidelines.

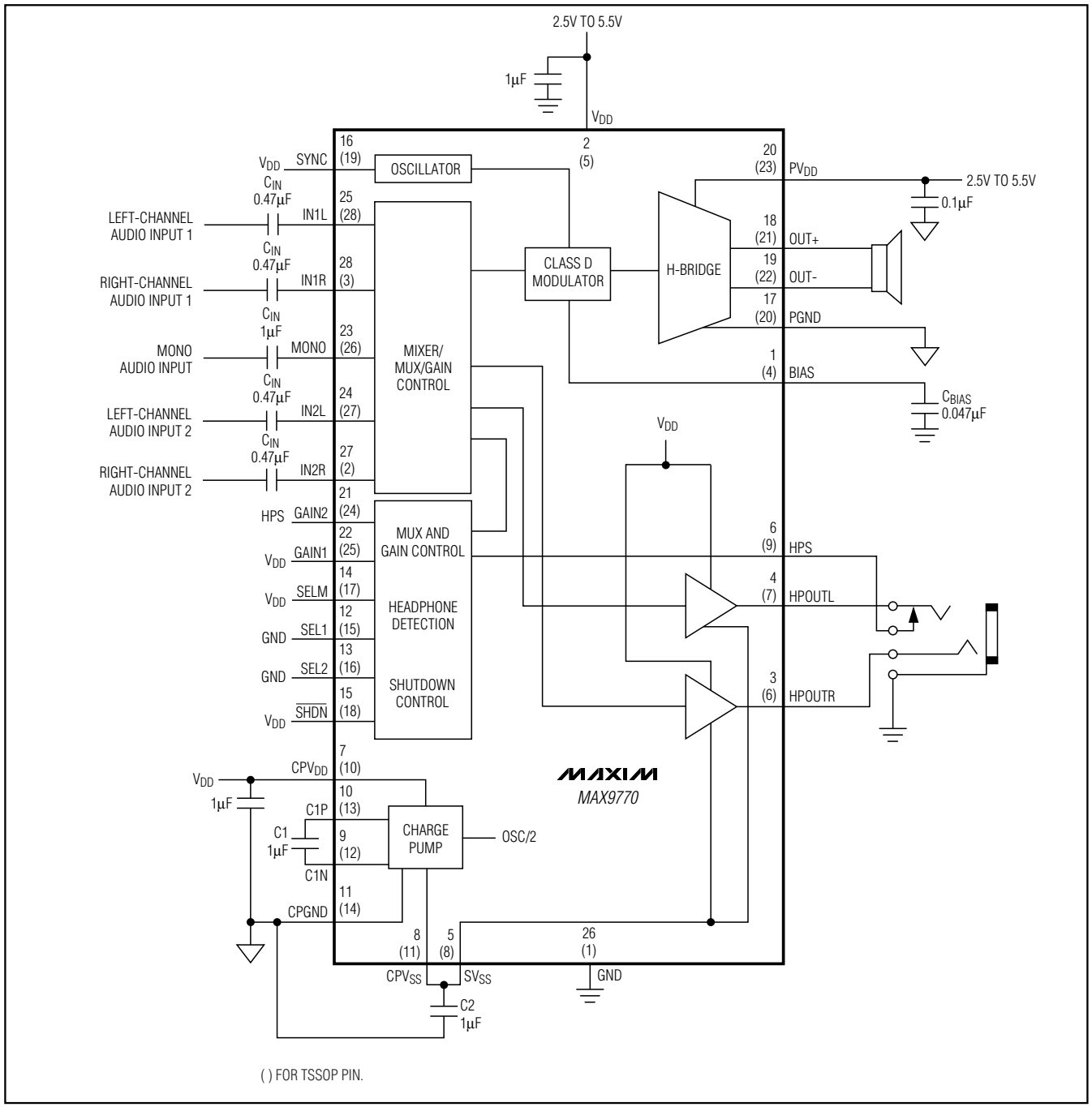
____*UCSP Applications Information*

For the latest application details on UCSP construction, dimensions, tape carrier information, PC board techniques, bump-pad layout, and recommended reflow temperature profile, as well as the latest information on reliability testing results, refer to the Application Note: *UCSP—A Wafer-Level Chip-Scale Package* on Maxim's web site at www.maxim-ic.com/ucsp.

*SV_{SS} and CPV_{SS} are internally connected to a single bump (B5) for the MAX9772.

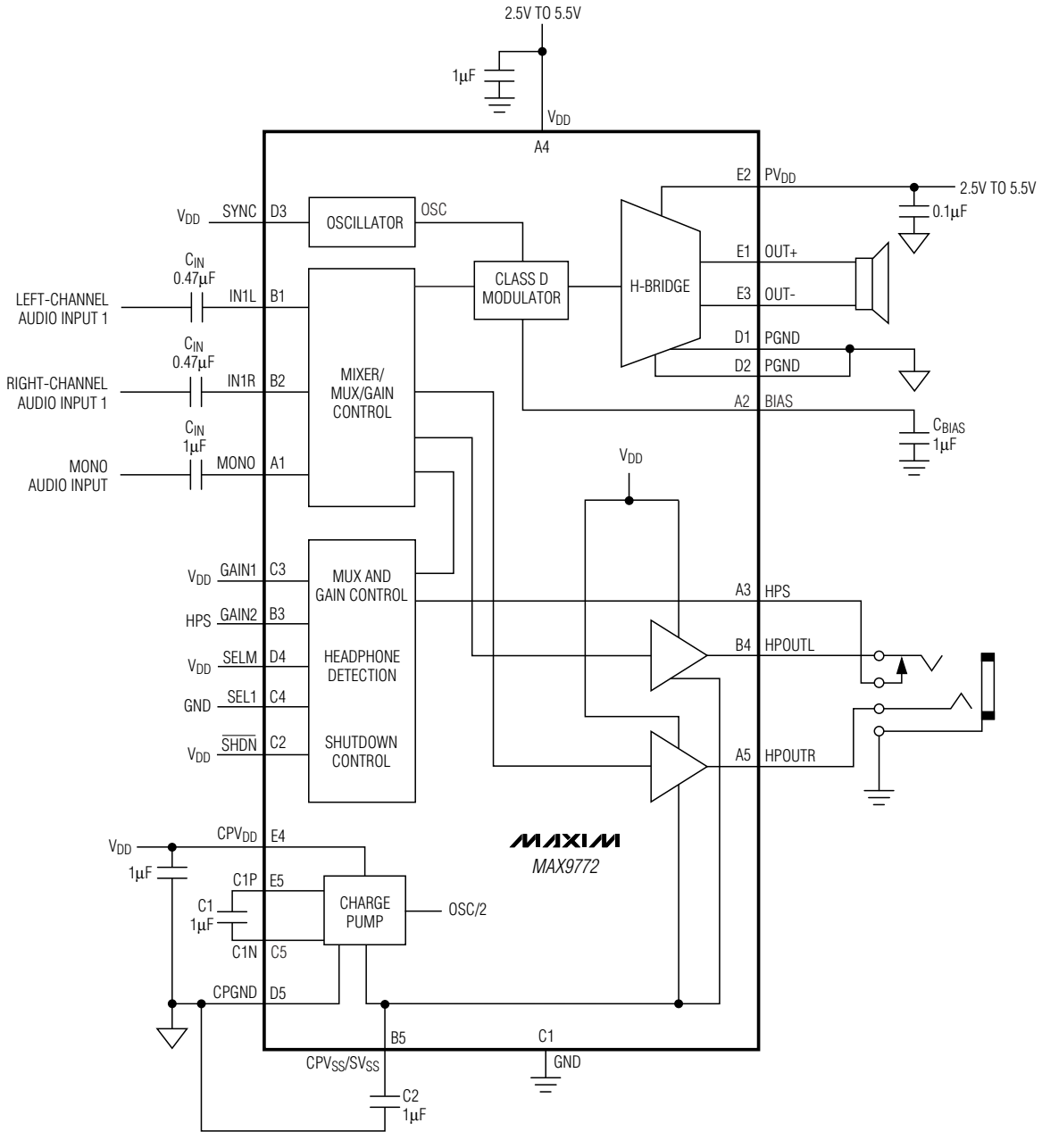
1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

Block Diagrams



1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

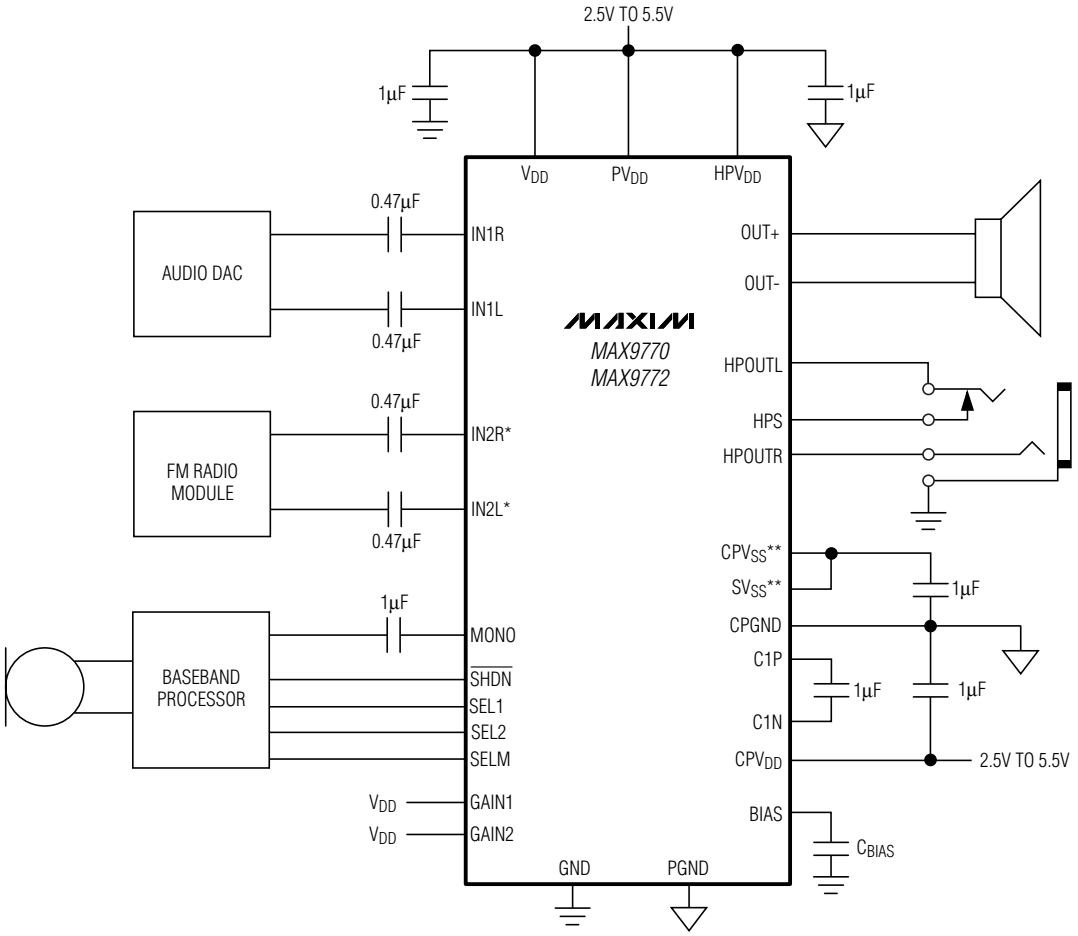
Block Diagrams (continued)



( ) FOR TSSOP PIN.

1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

System Diagram



*MAX9770 ONLY

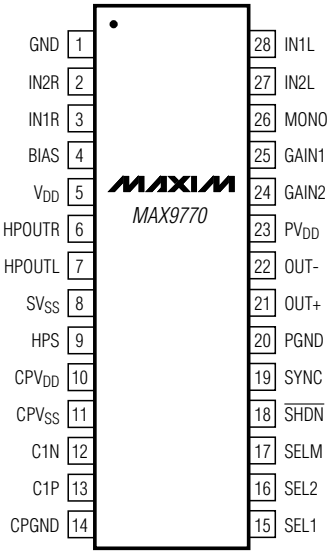
**SV_{SS} AND CPV_{SS} ARE INTERNALLY CONNECTED TO THE SAME BUMP ON THE MAX9772.

C_{BIAS} = 0.047µF FOR THE MAX9770 AND 1µF FOR THE MAX9772.

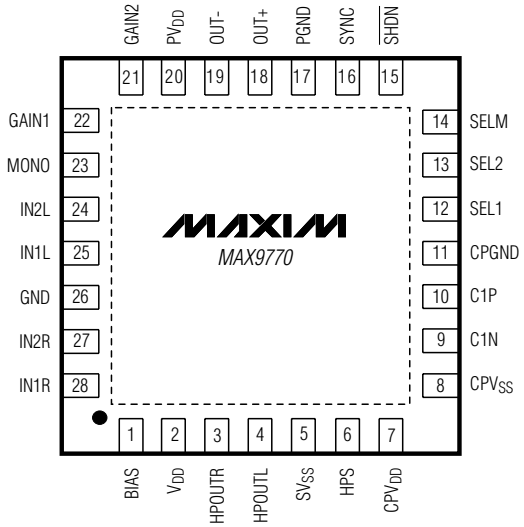
1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

Pin Configurations

TOP VIEW

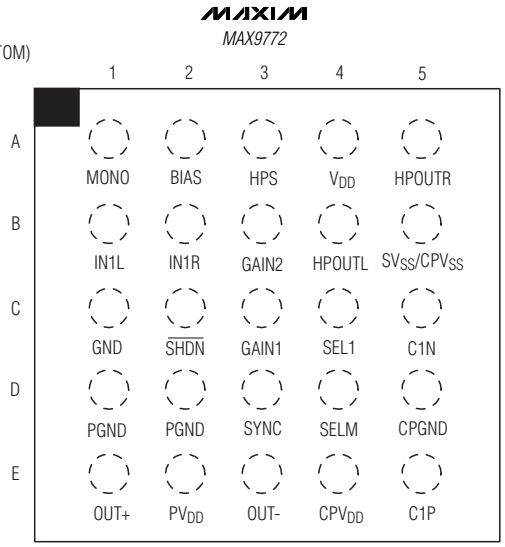


TSSOP



TQFN

TOP VIEW
(BUMPS ON BOTTOM)



UCSP (B25-1)

Chip Information

TRANSISTOR COUNT: 7020

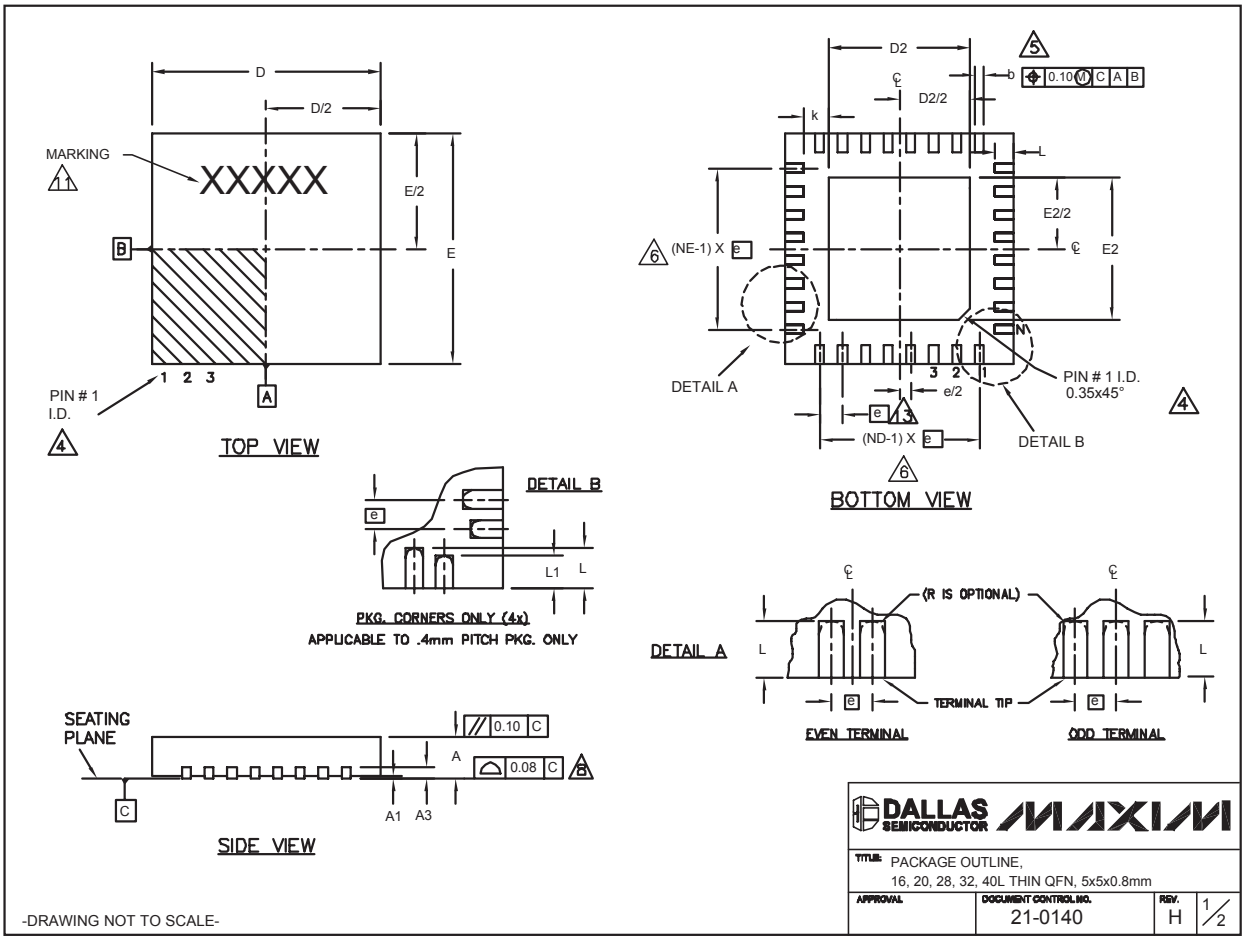
PROCESS: BiCMOS

1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)

QFN THIN.EPS



1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)

COMMON DIMENSIONS																
PKG.	16L 5x5			20L 5x5			28L 5x5			32L 5x5			40L 5x5			
SYMBOL	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
A	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	
A1	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05	
A3	0.20 REF.			0.20 REF.			0.20 REF.			0.20 REF.			0.20 REF.			
b	0.25	0.30	0.35	0.25	0.30	0.35	0.20	0.25	0.30	0.20	0.25	0.30	0.15	0.20	0.25	
D	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	
E	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	
e	0.80 BSC.			0.65 BSC.			0.50 BSC.			0.50 BSC.			0.40 BSC.			
k	0.25	-	-	0.25	-	-	0.25	-	-	0.25	-	-	0.25	0.35	0.45	
L	0.30	0.40	0.50	0.45	0.55	0.65	0.45	0.55	0.65	0.30	0.40	0.50	0.40	0.50	0.60	
L1	-	-	-	-	-	-	-	-	-	-	-	-	0.30	0.40	0.50	
N	16			20			28			32			40			
ND	4			5			7			8			10			
NE	4			5			7			8			10			
JEDEC	WHHB			WHHC			WHHD-1			WHHD-2			-----			

EXPOSED PAD VARIATIONS								
PKG. CODES	D2			E2			L	DOWN BONDS ALLOWED
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	±0.15	
T1655-1	3.00	3.10	3.20	3.00	3.10	3.20	**	NO
T1655-2	3.00	3.10	3.20	3.00	3.10	3.20	**	YES
T1655N-1	3.00	3.10	3.20	3.00	3.10	3.20	**	NO
T2055-2	3.00	3.10	3.20	3.00	3.10	3.20	**	NO
T2055-3	3.00	3.10	3.20	3.00	3.10	3.20	**	YES
T2055-4	3.00	3.10	3.20	3.00	3.10	3.20	**	NO
T2055-5	3.15	3.25	3.35	3.15	3.25	3.35	0.40	YES
T2855-1	3.15	3.25	3.35	3.15	3.25	3.35	**	NO
T2855-2	2.60	2.70	2.80	2.60	2.70	2.80	**	NO
T2855-3	3.15	3.25	3.35	3.15	3.25	3.35	**	YES
T2855-4	2.60	2.70	2.80	2.60	2.70	2.80	**	YES
T2855-5	2.60	2.70	2.80	2.60	2.70	2.80	**	NO
T2855-6	3.15	3.25	3.35	3.15	3.25	3.35	**	NO
T2855-7	2.60	2.70	2.80	2.60	2.70	2.80	**	YES
T2855-8	3.15	3.25	3.35	3.15	3.25	3.35	0.40	YES
T2855N-1	3.15	3.25	3.35	3.15	3.25	3.35	**	NO
T3255-2	3.00	3.10	3.20	3.00	3.10	3.20	**	NO
T3255-3	3.00	3.10	3.20	3.00	3.10	3.20	**	YES
T3255-4	3.00	3.10	3.20	3.00	3.10	3.20	**	NO
T3255N-1	3.00	3.10	3.20	3.00	3.10	3.20	**	NO
T4055-1	3.20	3.30	3.40	3.20	3.30	3.40	**	YES

** SEE COMMON DIMENSIONS TABLE

NOTES:

1. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
2. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES.
3. N IS THE TOTAL NUMBER OF TERMINALS.
4. THE TERMINAL #1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM TO JESD 95-1 SPP-012. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE TERMINAL #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE.
5. DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25 mm AND 0.30 mm FROM TERMINAL TIP.
6. ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.
7. DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION.
8. COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
9. DRAWING CONFORMS TO JEDEC MO220, EXCEPT EXPOSED PAD DIMENSION FOR T2855-1, T2855-3, AND T2855-6.
10. WARPAGE SHALL NOT EXCEED 0.10 mm.
11. MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.
12. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.
13. LEAD CENTERLINES TO BE AT TRUE POSITION AS DEFINED BY BASIC DIMENSION "e", ±0.05.

-DRAWING NOT TO SCALE-

DALLAS SEMICONDUCTOR MAXIM

TITLE: PACKAGE OUTLINE, 16, 20, 28, 32, 40L THIN QFN, 5x5x0.8mm

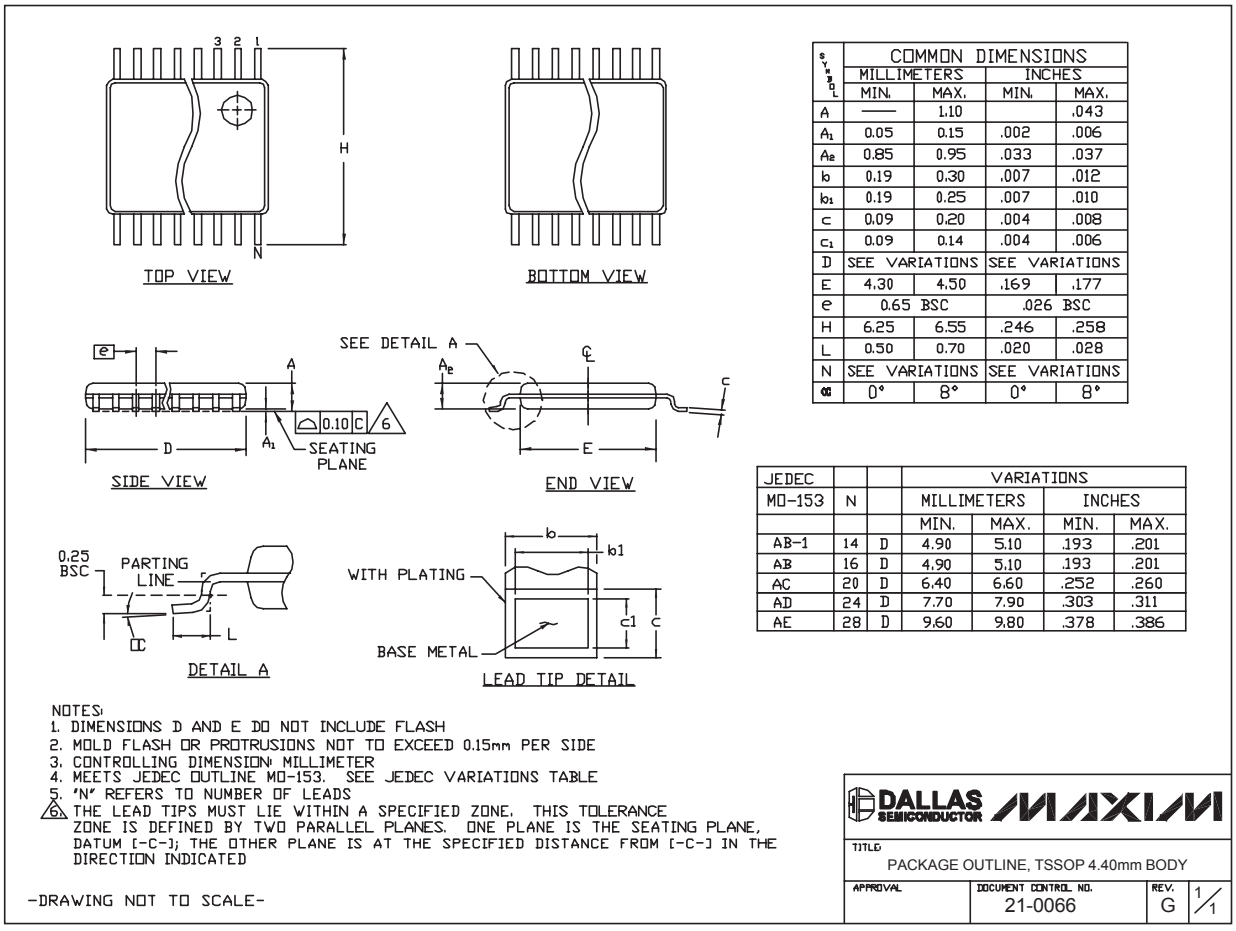
APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0140	H	2/2

1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)

TSSOP4.40mm.EPS



SYMBOL	COMMON DIMENSIONS			
	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	——	1.10		.043
A_1	0.05	0.15	.002	.006
A_2	0.85	0.95	.033	.037
b	0.19	0.30	.007	.012
b_1	0.19	0.25	.007	.010
c	0.09	0.20	.004	.008
c_1	0.09	0.14	.004	.006
D	SEE VARIATIONS		SEE VARIATIONS	
E	4.30	4.50	.169	.177
e	0.65 BSC		.026 BSC	
H	6.25	6.55	.246	.258
L	0.50	0.70	.020	.028
N	SEE VARIATIONS		SEE VARIATIONS	
α	0°	8°	0°	8°

JEDEC			VARIATIONS			
MO-153	N		MILLIMETERS		INCHES	
			MIN.	MAX.	MIN.	MAX.
AB-1	14	D	4.90	5.10	.193	.201
AB	16	D	4.90	5.10	.193	.201
AC	20	D	6.40	6.60	.252	.260
AD	24	D	7.70	7.90	.303	.311
AE	28	D	9.60	9.80	.378	.386

NOTES:
1. DIMENSIONS D AND E DO NOT INCLUDE FLASH
2. MOLD FLASH OR PROTRUSIONS NOT TO EXCEED 0.15mm PER SIDE
3. CONTROLLING DIMENSION: MILLIMETER
4. MEETS JEDEC OUTLINE MO-153. SEE JEDEC VARIATIONS TABLE
5. "N" REFERS TO NUMBER OF LEADS
6. THE LEAD TIPS MUST LIE WITHIN A SPECIFIED ZONE. THIS TOLERANCE ZONE IS DEFINED BY TWO PARALLEL PLANES. ONE PLANE IS THE SEATING PLANE, DATUM [-C-]; THE OTHER PLANE IS AT THE SPECIFIED DISTANCE FROM [-C-] IN THE DIRECTION INDICATED

-DRAWING NOT TO SCALE-

DALLAS SEMICONDUCTOR MAXIM

TITLE: PACKAGE OUTLINE, TSSOP 4.40mm BODY

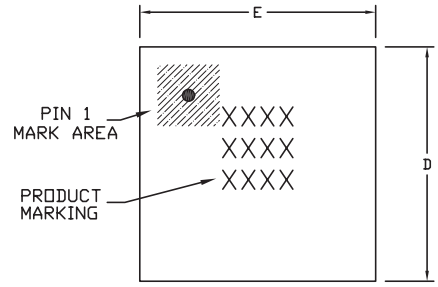
APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0066	G	1/1

1.2W, Low-EMI, Filterless, Mono Class D Amplifier with Stereo DirectDrive Headphone Amplifiers

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)

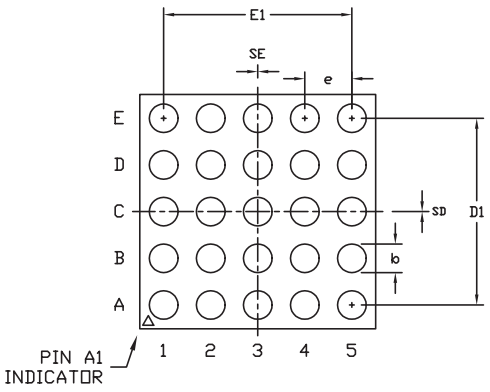
25L, UCSP.EPS



TOP VIEW

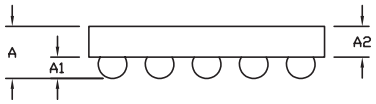
COMMON DIMENSIONS	
A	0.62+0.05-0.08
A1	0.29±0.02
A2	0.33 REF.
b	ø0.35±0.03
D	2.54±0.08
D1	2.00 BASIC
E	2.54±0.08
E1	2.00 BASIC
e	0.50 BASIC
SD	0.00 BASIC
SE	0.00 BASIC

PKG. CODE	DEPOPULATED SOLDER BALLS
B25-1	NONE
B25-2	D2, D3, D4
B25-3	B2, B3, B4
B25-4	B3, C2, C3, C4, D3



BOTTOM VIEW

NOTES:
1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. PRODUCT MARKING: NUMBER OF CHARACTERS AND LINES VARY PER PRODUCT.



SIDE VIEW

DALLAS SEMICONDUCTOR MAXIM
PROPRIETARY INFORMATION

TITLE: PACKAGE OUTLINE, 5x5 UCSP

APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0096	H	1/1

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